

fischertechnik Simulation and Training Model Information Guide

Version Two: Revised June 9, 2020



Using 24V Models with PLCs

PLC Input Instructions

Component Data Sheets

Material to be used in conjunction with PDF documentation for individual models

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https://www.studica.com/fischertechnik-industrial-simulation-training-models

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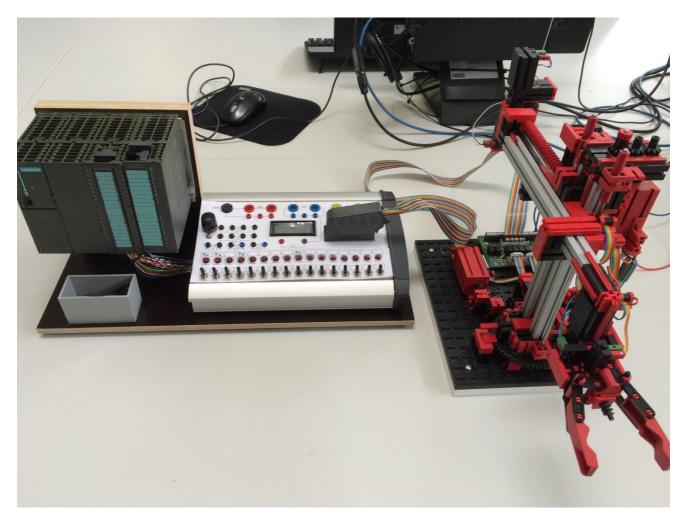
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(888) 561-7521



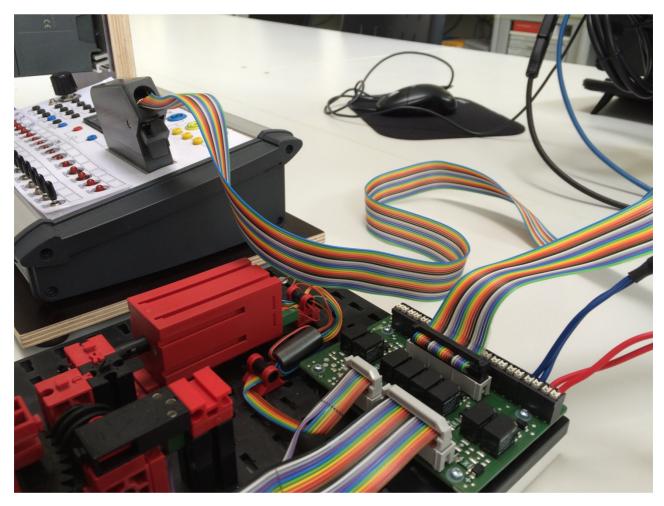
Examples for Training models 24V with PLC

1. 3-D-Robot with Siemens S7-300



Inputs and Outputs are directly connected to the adaptor PCB of the 3-D-Robot. No additional components e.g pullup resistors) necessary. Inputs of the PLC: PNP-sensors

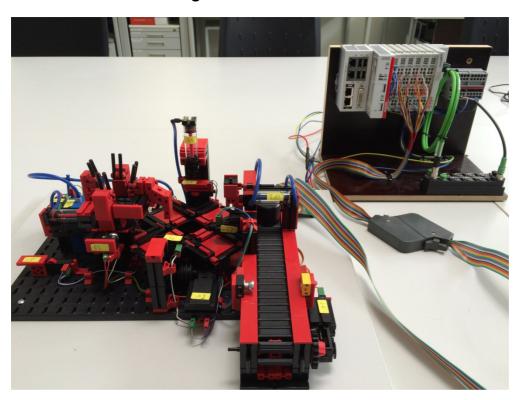


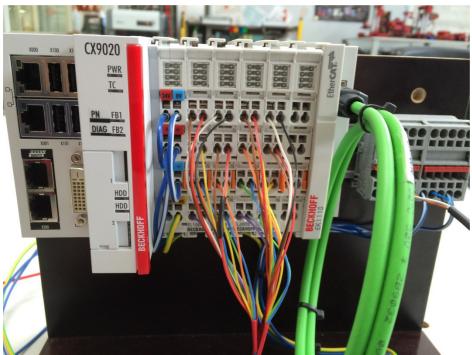






2. Pneumatic Processing center with Beckhoff PLC CX 9020

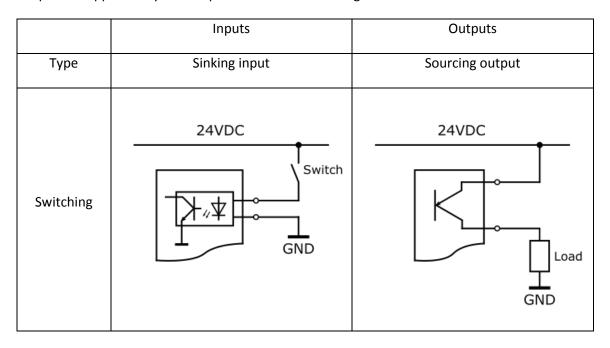




Inputs and Outputs are directly connected to the adaptor PCB of the 3-D-Robot. No additional components e.g pullup resistors) necessary. Inputs of the PLC: PNP-sensors.

PLC-Inputs

Normally PLCs use inputs as <u>"PNP- sensors"</u>. This means, that a positive potential (24VDC) is switched by the input. This kind of inputs is supported by our adaptor PCB on each training model



Additional components on the PCB:

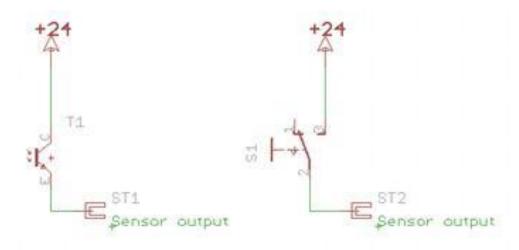
Diode: to avoid damages if + and – will be changed.

Polyswitch to avoid damages in case of shortcuts.

If your PLC uses "<u>NPN-sensors</u>": In this case the Input does not use a positive level but ground signal. In this case please contact us, we can tell you how you can adapt PCB to this configuration.

How to connect a phototransistor to a PLC:

The phototransistor can be connected like a switch. Both can put through +24V. The phototransistor puts through the 24V when it is lighted. The only difference between a switch and a phototransistor is its internal resistance which depends on the lighting. If the internal resistance of the digital inputs of the PLC is too low it might be that the level of the phototransistor is not high enough to switch the digital input of the PLC. In this case it helps to connect a resistor parallel to the phototransistor in order to change the operating point so that the input of the PLC can react. This resistance depends on the threshold level of the PLC and its internal resistance. For the most common PLCs (e.g. Siemens S7-1200) no additional resistance is needed.





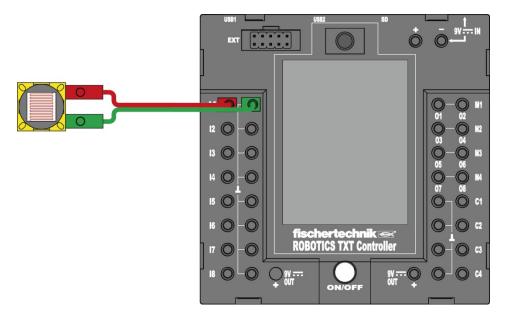
ArtNr. part. no.	32698	
Bezeichnung name	Fotowiderstand LDR03 Photoresistor LDR03	
Abmessungen dimensions:	15x15x15mm (ohne Anschlussdrähte) (without connecting wires)	
Gewicht weight:	2,8g	
R 10	3-11kΩ	
R 100	1,2kΩ	
Wellenlänge: wavelength	600nm	

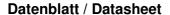
Signal: Widerstandswert 1,2kΩ bei 100Lux und Lichtwellenlänge 600nm

Signal: Resistor value: 1,2kΩ at 100Lux and wavelength 600nm,

Anschlüsse: 2 Buchsen für fischertechnik Stecker Ø 2,5mm Connections:2 connectors for fischertechnik plugs Ø 2,5mm

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Analog $5k\Omega$ Connection to TXT Controller at Inputs I1-I8, Input mode: Analogue $5k\Omega$







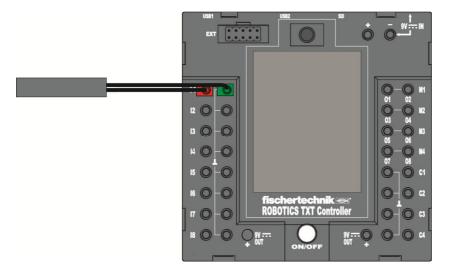
ArtNr. part. no.	36120	
Bezeichnung name	Reedkontakt Reed switch	
Abmessungen dimensions:	25xØ4 mm	
Gewicht weight:	3,5g	
Schaltleistung: Switching power:	max. 0,5A, 50V	

Signal: Digitaler magnetischer Schalter 0 / 1 für Magnetbaustein Art.-Nr. 108278

Signal: Digital magnetic switch 0 /1, can be used together with magnetic component part no. 108278

Anschlüsse: 2 cables, Schwarz, Länge: 30cm Connections:2 cables, black, length 30 cm

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Digital $5k\Omega$ Connection to TXT Controller at Inputs I1-I8, Input mode: digital $5k\Omega$



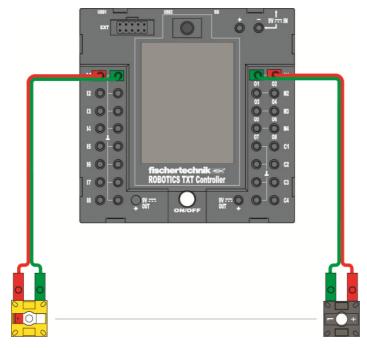


ArtNr. part. no.	36134	
Bezeichnung name	Fototransistor Photo-transistor	0 0
Abmessungen dimensions:	15x15x7,5mm	
Gewicht weight:	1,7g	
Typ: <i>Type:</i>	NPN-Silizium-Fototransist	or für Lichtschranke (mit Lichtschranken LED Art. Nr. 162135)

Kollektor-Emmiterspannung V _{CE}	35V
Collector-emitter voltage V _{CE}	
Kollektorstrom I _C	15mA
Collector current I _C	
Kollektorspitzenstrom I _{CS}	75mA
Collector surge current I _{CS}	

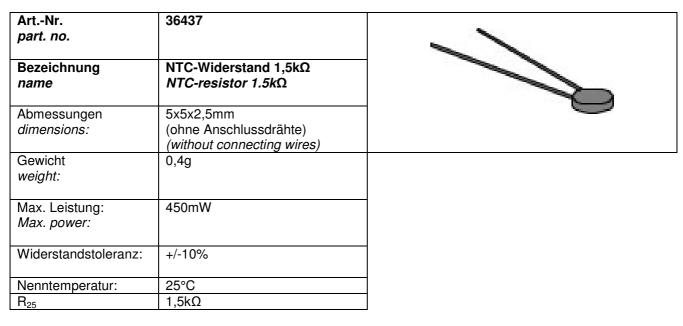
Anschlüsse: 2 Buchsen für fischertechnik Stecker Ø 2,5mm, rote Markierung = + Connections:2 female connetors for fischeretchnik plugs Ø 2,5mm

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Digital $5k\Omega$ Connection to TXT Controller at Inputs I1-I8, Input mode: digital $5k\Omega$



Fototransistor Phototransistor LED 162135



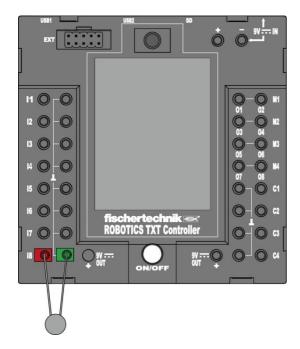


Signal: Widerstandswert 1,5k Ω bei 25°C, **N**egativer **T**emperatur **C**oefficient. Widerstand sinkt bei steigender Temperatur. R/T-Kennlinie Nr. 1013.

Signal: Resistor value: 1,5 $5k\Omega$ bei 25°C, **N**egative **T**emperature **C**oefficient, resistance decreases when temperature raises. R/T-curve: No. 1013

Anschlüsse: 2 Drähte, Länge: ca. 35mm Connections:2 wires, length: ca. 35mm

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Analog $5k\Omega$ Connection to TXT Controller at Inputs I1-I8, Input mode: Analogue $5k\Omega$





Normierte R/T-Kennlinien Standardised R/T-curves

Nummer	1011		1012		1013		1014	
T(°C)	$B_{25/100} = 37$	730 K	B _{25/100} = 4300 K		$B_{25/100} = 39$	900 K	$B_{25/100}$ = 4250 K	
	R_{T}/R_{25}	α (%/K)	$R_{\rm T}/R_{25}$	α (%/K)	$R_{\rm T}/R_{25}$	α (%/K)	R_{T}/R_{25}	α (%/K)
- 55,0	70,014	6,9	87,237	6,8	77,285	7,0	83,935	6,8
-50,0	49,906	6,7	62,264	6,7	54,938	6,7	60,228	6,6
-45,0	36,015	6,4	44,854	6,5	39,507	6,5	43,593	6,4
-40,0	26,296	6,2	32,599	6,3	28,722	6,3	31,815	6,3
-35,0	19,411	6,0	23,893	6,1	21,099	6,1	23,404	6,1
-30,0	14,479	5,8	17,654	6,0	15,652	5,9	17,349	6,0
-25,0	10,903	5,6	13,098	5,8	11,715	5,7	12,946	5,8
-20,0	8,2923	5,4	9,8059	5,7	8,8541	5,6	9,7439	5,7
- 15,0	6,3591	5,2	7,4266	5,5	6,7433	5,4	7,3737	5,5
-10,0	4,9204	5,1	5,6677	5,4	5,1815	5,2	5,6247	5,4
- 5,0	3,8279	4,9	4,3213	5,3	4,0099	5,1	4,3063	5,3
0,0	3,0029	4,8	3,3208	5,1	3,1283	4,9	3,3221	5,2
5,0	2,3773	4,6	2,5842	5,0	2,4569	4,8	2,5779	5,0
10,0	1,8959	4,5	2,0238	4,9	1,9438	4,6	2,0144	4,9
15,0	1,5207	4,3	1,5858	4,8	1,5475	4,5	1,5848	4,8
20,0	1,2280	4,2	1,2507	4,7	1,2403	4,4	1,2547	4,6
25,0	1,0000	4,1	1,0000	4,5	1,0000	4,3	1,0000	4,6
30,0	0,81779	3,9	0,79640	4,4	0,81104	4,1	0,79913	4,4
35,0	0,67341	3,8	0,64053	4,3	0,66146	4,0	0,64287	4,3
40,0	0,55747	3,7	0,51772	4,2	0,54254	3,9	0,51991	4,2
45,0	0,46357	3,6	0,41958	4,1	0,44727	3,8	0,42299	4,1
50,0	0,38740	3,6	0,34172	4,1	0,37067	3,7	0,34573	4,1
55,0	0,32368	3,5	0,27877	4,0	0,30865	3,6	0,28298	4,0
60,0	0,27200	3,4	0,22861	3,9	0,25825	3,5	0,23277	3,8
65,0	0,23041	3,3	0,18872	3,8	0,21707	3,4	0,19262	3,8
70,0	0,19604	3,2	0,15645	3,7	0,18323	3,3	0,16005	3,7
75,0	0,16735	3,1	0,13012	3,6	0,15535	3,3	0,13349	3,6
80,0	0,14342	3,0	0,10863	3,6	0,13223	3,2	0,11175	3,5
85,0	0,12347	3,0	0,091115	3,5	0,11302	3,1	0,093934	3,5
90,0	0,10668	2,8	0,076700	3,4	0,096951	3,0	0,079231	3,4
95,0	0,092734		0,064867			3,0	0,067054	
100,0	0,080903	2,8	0,055047	3,3	0,072139	2,9	0,056932	3,2
105,0	0,070616	2,7	0,046797	3,2	0,062559	2,8	0,048591	3,1
110,0	0,061826	2,6	0,039904	3,1	0,054425	2,8	0,041605	3,1
115,0	0,054282	2,6	0,034255	3,1	0,047508	2,7	0,035653	3,1
120,0	0,047793	2,5	0,029498	3,0	0,041594	2,6	0,030636	3,0
125,0	0,042249	2,4	0,025448	3,0	0,036532	2,6	0,026454	2,9
130,0	0,037450	2,4	0,022016	2,9	0,032175	2,5	0,022905	2,9
135,0	0,033244	2,4	0,019038	2,8	0,028423	2,5	0,019867	2,8



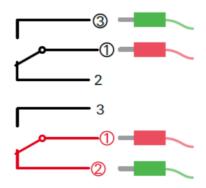
Nummer	1011		1012		1013		1014	
T(°C)	B _{25/100} = 3730 K		B _{25/100} = 4300 K		B _{25/100} = 3900 K		B _{25/100} = 4250 K	
	$R_{\rm T}/R_{25}$	α (%/K)						
140,0	0,029582	2,3	0,016502	2,8	0,025173	2,4	0,017274	2,8
145,0	0,026406	2,3	0,014355	2,7	0,022358	2,4	0,015027	2,8
150,0	0,023625	2,2	0,012514	2,7	0,019907	2,3	0,013101	2,7
155,0	0,021193	2,1	0,010932	2,6	0,017770	2,2	0,011453	2,7
160,0	0,019057	2,1	0,0095681	2,6	0,015901	2,2	0,010031	2,6
165,0	0,017176	2,1	0,0083903	2,5	0,014263	2,2	0,0088012	2,6
170,0	0,015516	2,0	0,0073706	2,5	0,012824	2,1	0,0077359	2,6
175,0	0,014046	2,0	0,0065718	2,5	0,011556	2,1	0,0068109	2,5
180,0	0,012742	2,0	0,0058179	2,4	0,010436	2,1	0,0060061	2,5



ArtNr. part. no.	37783	
Bezeichnung name	Mini-Taster Mini switch	
Abmessungen dimensions:	30x15x7,5mm	
Gewicht weight:	3,4g	
Schaltleistung: Switching power:	max. 2A, 50V	

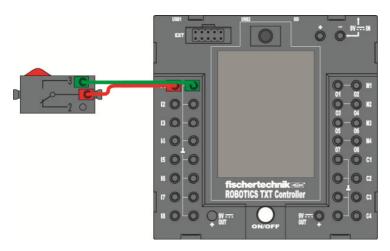
Signal: Digitaler Schalter 0 / 1, als Öffner oder Schließer verwendbar

Signal: Digital switch 0 /1, can be used aus "normally open" or "normally closed"



Anschlüsse: Kontakte 1 und 3: "Schließer", Kontakte 1 und 2 angeschlossen: "Öffner" Connections: Contacts 1 and 3: NO (normally open) Contacts 1 and 2: NC (normally closed)

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Digital $5k\Omega$ Connection to TXT Controller at Inputs I1-I8, Input mode: digital $5k\Omega$





ArtNr. part. no.	128598	
Bezeichnung name	Spursensor Trail sensor	
Abmessungen dimensions:	30x15x15mm	
Gewicht weight:	7,3g	
Spannungsversorgung Supply voltage:	6-10 VDC	Stromaufnahme: ca.30mA Current consumption:

Signal: Zwei Digitalwerte zum Erkennen einer schwarzen Spur 0=schwarz (0V), 1=weiß (max. 9V abhängig von Eingangsspannung).

Signal: Two digital values for recognition of a black trail 0=black (0V), 1=white (max. 9V depending on input voltage)

Spurbreite: 20mm

Track width:

Minimaler Abstand: 8mm

Minimum distance:

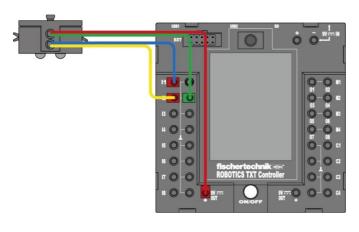
Maximaler Abstand: 25mm

Maximum distance:

Anschlüsse: rot=9VDC, grün=Masse, gelb, blau=Signal Connection: red=9VDC, green=ground, yellow, blue=signal

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Digital Spannung Connection to TXT Controller at Inputs I1-I8, Input mode: Digital Voltage

Anschluss an TXT Controller: Connection to TXT Controller:





ArtNr. part. no.	128599				
Bezeichnung name	Farbsensor Color sensor				
Abmessungen dimensions:	30x15x15mm				
Gewicht weight:	6,8g				
Spannungsversorgung Supply voltage:	6-10 VDC	Stromaufnahme: ca. 15mA Current Consumption:			

Signal: Analogwert 0-2VDC. Ausgabe in mV. Kein RGB-Sensor. Licht wird von einer LED ausgesendet und von unterschiedlichen Farben unterschiedlich stark reflektiert. Das reflektierte Licht wird gemessen. Ähnliche Farben können ähnliche Werte erzeugen. Der Messwert ist abhängig von der Umgebungsbeleuchtung und dem Abstand zum Objekt.

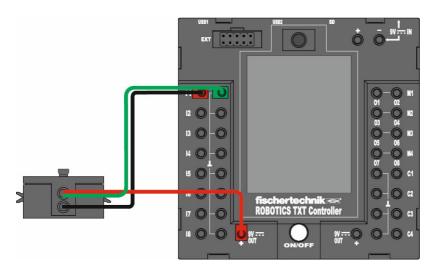
Signal: Analogue value 0-2VDC. Output in mV. No RGB sensor. Light is sent out by a LED and will be reflected by different colors in a different way the reflected amount of light will be measured. Similar colors can lead to similar values. The measured value depends on the brightness in the environment and the distance to the oject.

Anschlüsse: rot=9VDC, grün=Masse, Schwarz=Signal Connection: red=9VDC, green=ground, black=signal

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Analog Spannung Connection to TXT Controller at Inputs I1-I8, Input mode: Analogue Voltage

Wertebereich 0-2000mV Value range: 0-2000mV

Anschluss an TXT Controller: Connection to TXT Controller:





ArtNr. part. no. Bezeichnung name	133009 Ultraschall- Abstandssensor Ultra sonic dis-	
Abmessungen dimensions:	tance sensor 45x30x15mm	
Gewicht weight:	20,5g	
Spannungsversorgung Supply voltage:	5-10 VDC	

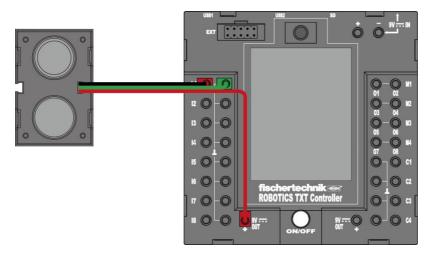
Signal: digital codierte Datenübertragung zwischen ROBO TX Controller/ROBO Interface und Sensor Signal: digital coded data transfer between ROBO TX Controller and sensor

Anschlüsse: rot=9VDC, grün=Masse, Schwarz=Signal connection: red=9VDC, green=ground, black=signal

Anschluss an TXT Controller an Eingängen I1-I8, Eingangsart: Ultraschall connection to TXT Controller at Inputs I1-I8, Input mode: Ultrasonic

Wertebereich 3-400cm, Ausgabewert entspricht Abstand in cm. Genauigkeit +/- 0,5cm, 1023=unendlich Value range: 3-400cm, value corresponds to distance in cm. Resolution +/-0.5cm, 1023=infinite

Anschluss an TXT Controller: Connection to TXT Controller:



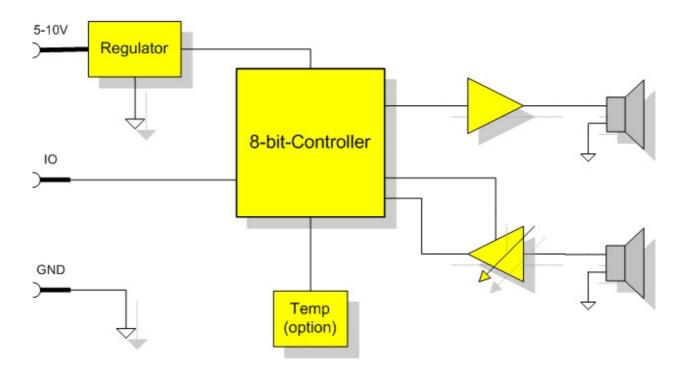
Daten-Protokoll: siehe Anhang "hardware concept" data protocol: see attached file "hardware concept"

Hardware - Concept USONIC2008 RevA Ultrasonic distance sensor modul

1. Features

- Distance measurement from 4 400 cm
- Double ultrasonic speaker for low distance recognition
- accuracy better than 2% or 1 cm (partly temperature compensated)
- bidirectional digital interface, resolution 0,5 cm (10bit)
- 3-wire interface, connectable to universal Interface2008 inputs
- Multi sensor use without influence (up to 8)
- Voltage supply 5 − 10 Volt

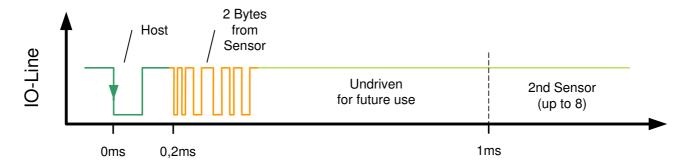
2. Diagram



2. Protocol

2.1 Single bidirectional IO-Line

• Ultrasonic sensor waits for host trigger pulse to synchronize all sensors



2.2 Host query

- low pulse with 78,125us duration (= '0'-Byte with 115200 Baud, 8N1)
- tristate after 90us
- repeated every 10ms

2.3 Sensor answer

- sensor synchronizes to falling edge
- 2 Byte answer in 0.2 1ms timeslot
- Asynchron, 115200 Baud, 1 Startbit, no parity, 1 Stopbit
- Output: open collector, 100K-Pullup to Vin (5-10V)
- answer is not mendatory
- without host trigger sensor goes into standby
- weak pullup at sensor side (avoids floating during undriven states)
- protocol expandable to ASN1 protocol chain

2.4 Sensor answer: 2 Bytes

First Byte

	D7	D6	D5	D4	D3	D2	D1	D0
ĺ	1	Valid#	W/D#	ID1	ID0	L9	L8	L7

Second Byte

D7	D6	D5	D4	D3	D2	D1	D0
0	L6	L5	L4	L3	L2	L1	L0

Bit Definition

Valid#: 0 = valid, 1= unvalid
 W/D#: 0 = distance, 1 = weight

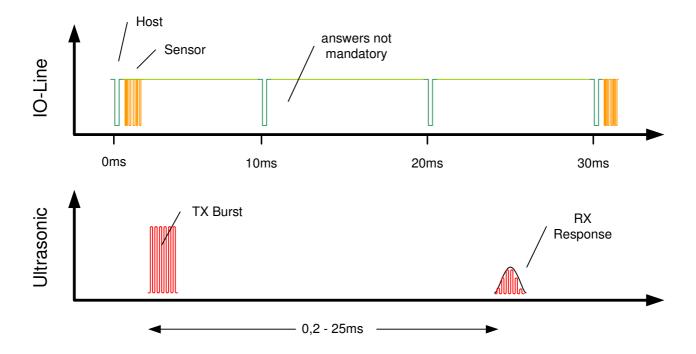
 \circ ID: 0 = first echo, 1 = second echo, 2 = third echo

L9..0: 10 bit, distance (0.5 cm), weight in range from 0 - 64

Val=0x000 distance lower than 4 cm
 Val=0x3FF distance higher than 400 cm

2.5 IO protocol vs. Ultrasonic timing

- Ultrasonic burst should start after data transmit
- Sequential procedure for easy firmware timing



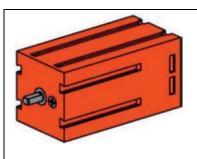
2.6 Options

- Further protocol options on request
 - o e. g. firmware update via IO-line
 - o multi echo recognition
 - o controller frequency adjustment by triggersensing



FT-T-KN 2018-10-25

Datenblatt Encodermotor 9V Art.-Nr. 135484 Datasheet Encoder motor 9V Art. No. 135484



Maße/dimensions: 60x30x30mm

Abtriebswelle/output shaft: D=4mm, L=7,5mm, 2 Abflachungen je 0,7mm/ 2 bevels 0.7mm each

Stromversorgung: 9VDC über 2 fischertechnik Anschlussbuchsen

D=2,5mm/

Power supply: 9VDC with 2 fischertechnik connection sock-

etsD=2.5mm

Motordaten/motor data:

Constant voltage: 9V DC reduction ratio: 25:1

No load speed: 320 (+/-33) rpm
No load current: 0,16A max.
Rated speed: 230 (+/-26) rpm
rated torque: 0,25 Kgcm min
rated current: 0,35A max

Stall torque: 0,70Kgcm min (not allow the torque)

Stall current: 1,1A max.

Encoderdaten/encoder data:

Magnetencoder

Stromversorung/power supply: 9VDC

Signal: Encodersignal, Push-Pull Output (0/9V), max. 10mA

Frequenz/frequency: max 1kHz.

Anschlüsse/connector: 3-pol Stiftleiste, passendes Kabel/fitting cable: Art.No. 137125 rot/red=+9V, grün/green=0V,

schwarz/black=Encodersignal/encoder signal

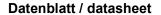


Versorgungsspannung Encoder/supply voltage encoder: 9V DC Signal: NPN Open Kollector Ausgang, max. 2mA belastbar/signal: npn open collector output, max. 2mA

Bei Anschluss an einen digitalen Eingang einer Steuerung (nicht fischertechnik-Controller): Pull-up-Widerstand 4.7-10kOhm notwendig zwischen Encodersignal und Prozessorstromversorgung (bei 3,3-5V)

When the encoder motor is connected to a digital input of any control units (not fischertechnik controllers) a pull-up resistance of 4.7-10kOhms is needed between the encoder signal and the processor power supply (3.3V or 5V).







Pins (Encoderkabel): grün: Masse (-), rot: 9V+, schwarz: Encodersignal Pins (encoder cable): green: 0V (-), red: 9V+, black: encoder signal

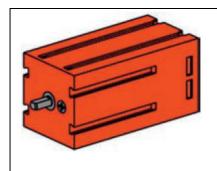
Auflösung des Encoders: 3 Impulse (6 Impulse wenn 0-1 und 1-0-Flanke gezählt wird) pro Umdrehung des Motors. 63,3/126,6 Impulse pro Umdrehung der Getriebe-Abtriebsachse

Resolution of encoder: 3 pulses (6 pulses when counting 0-1 and 1-0 edge) per round of motor. 63.9/127.8 pulses per round of the gear shaft.



FT-T-KN 11.04.2017

Datenblatt Encodermotor 24V Art.-Nr. 144643 Datasheet Encoder motor 24V Art. No. 144643



Maße/dimensions: 60x30x30mm

Abtriebswelle/output shaft: D=4mm, L=7,5mm, 2 Abflachungen je 0,7mm/ 2 bevels 0.7mm each

Stromversorgung: 24VDC über 2 fischertechnik Anschlussbuch-

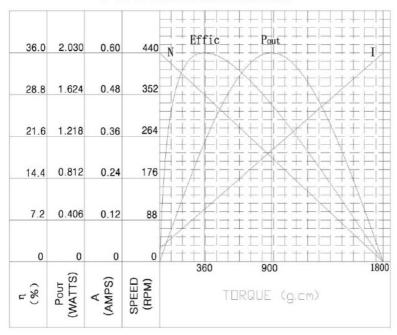
sen D=2,5mm/

Power supply: 24VDC with 2 fischertechnik connection sock-

etsD=2.5mm

Motordaten/motor data:

T-N-I CHARACTERISTICS



Encoderdaten/encoder data:

Quadraturencoder,

Stromversorung/power supply 24VDC

Signal: Quadratur Encoder, Push-Pull Output (0/24V), max. 10mA

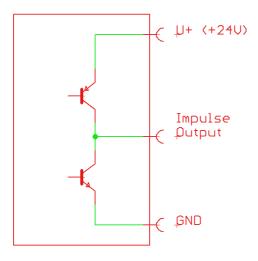
Frequenz/frequency: max 1kHz.

Anschlüsse/connector: 4-pol Stiftleiste, passendes Kabel/fitting cable: Art.No. 119785 rot/red=+24V, grün/green=0V, schwarz/black=Puls1, gelb/yellow=Impuls2

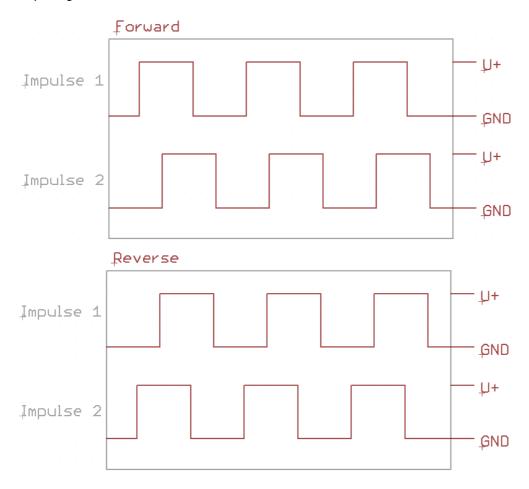




Ersatzschaltbild eines 24V Encoder-Ausgangs (2 pro Motor) Equivalent circuit diagram of 24V encoder output (2 per motor)

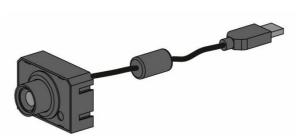


Ausgangssignal des 24V-Encoders für verschiedene Drehrichtungen. Output signal of 24V-encoder for different directions of rotation





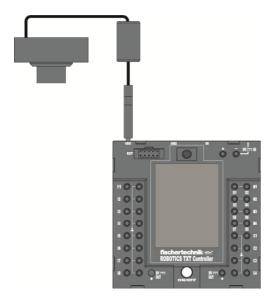
ArtNr. part. no.	152522	
Bezeichnung name	USB-Kameramodul USB-Cameramodule	
Abmessungen dimensions:	45x30x30,5mm (ohne Anschlusskabel) (without connecting cable)	
Gewicht: weight:	47,8g	
Auflösung: resolution:	1MPixel, RGB	
Fokus: Focus:	Manuell manually	



Signal: USB-Protokol, 15 fps (frames per second) QVGA über TXT Controller Signal: USB-Protocoll, 15fps (frames per second QVGA via TXT Controller

Anschlüsse: USB-Kabel, Länge 80cm, USB-A-Stecker Connections:USB-cable, length 80cm, USB-A-plug

Anschluss an TXT Controller an USB1 Connection to TXT Controller at USB1



Verfügbare Bildverarbeitungsroutinen in ROBOPro:

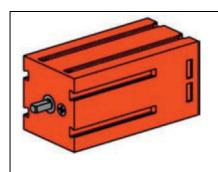
Bewegungserkennung, Farberkennung, Spurerkennung (farbig), Ballerkennung

Available Image processing routines in ROBOPro:

motion recognition, color recognition, trail recognition (color), ball recognition



Datenblatt Encodermotor 9V Art.-Nr. 153422 Datasheet Encoder motor 9V Art. No. 153422



Maße/dimensions: 60x30x30mm

Abtriebswelle/output shaft: D=4mm, L=7,5mm, 2 Abflachungen je 0,7mm/ 2 bevels 0.7mm each

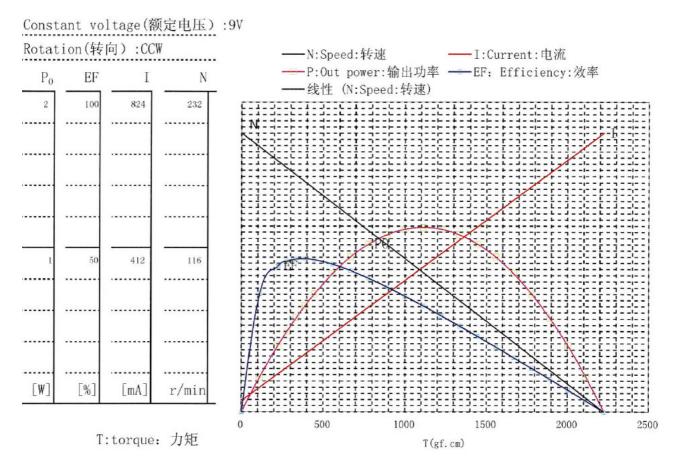
Stromversorgung: 9VDC über 2 fischertechnik Anschlussbuchsen

D=2,5mm/

Power supply: 9VDC with 2 fischertechnik connection sock-

etsD=2.5mm

Motordaten/motor data:

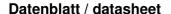


Nennspannung Motor/rated voltage motor: 9V DC

Max. Leistung/max. power: 1,2 W

Drehzahl bei max. Leistung/speed at max. power: 105 U/min (rpm). Drehmoment bei max. Leistung/torque at maximum power: 109 mNm Stromaufnahme bei max. Leistung/current at max. power: 386 mA

Getriebeuntersetzung: 21,3:1 /gear reduction: 21,3:1





Encoderdaten/encoder data:

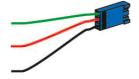
Magnetencoder

Stromversorung/power supply: 9VDC

Signal: Encodersignal, Push-Pull Output (0/9V), max. 10mA

Frequenz/frequency: max 1kHz.

Anschlüsse/connector: 3-pol Stiftleiste, passendes Kabel/fitting cable: Art.No. 137125 rot/red=+9V, grün/green=0V, schwarz/black=Encodersignal/encoder signal



Versorgungsspannung Encoder/supply voltage encoder: 9V DC Signal: NPN Open Kollector Ausgang, max. 2mA belastbar/signal: npn open collector output, max. 2mA

Bei Anschluss an einen digitalen Eingang einer Steuerung (nicht fischertechnik-Controller): Pull-up-Widerstand 4.7-10kOhm notwendig zwischen Encodersignal und Prozessorstromversorgung (bei 3,3-5V)

When the encoder motor is connected to a digital input of any control units (not fischertechnik controllers) a pull-up resistance of 4.7-10kOhms is needed between the encoder signal and the processor power supply (3.3V or 5V).

Pins (Encoderkabel): grün: Masse (-), rot: 9V+, schwarz: Encodersignal Pins (encoder cable): green: 0V (-), red: 9V+, black: encoder signal

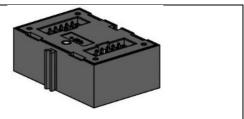
Auflösung des Encoders: 3 Impulse (6 Impulse wenn 0-1 und 1-0-Flanke gezählt wird) pro Umdrehung des Motors. 63,3/126,6 Impulse pro Umdrehung der Getriebe-Abtriebsachse

Resolution of encoder: 3 pulses (6 pulses when counting 0-1 and 1-0 edge) per round of motor. 63.9/127.8 pulses per round of the gear shaft.





Combi Sensor part no. 158402 3-in-1 absolute-orientation sensor



Quick reference guide

The fischertechnik 3-in-1 absolute-orientation sensor contains an acceleration sensor, a gyroscope and a geomagnetic sensor which can be addressed by the I²C interface of the ROBOTICS TXT Controller as three independent devices. The connection of the sensor is made by a ribbon cable (117336), which is attached to the TXT controller via the extension port (EXT) and a single power line (9V), which is plugged into the 9V OUT connector of the TXT controller. The correct connection can be seen in Figure 1. A detailed description of the sensor can be found in the manual of the used MEMS sensor by Bosch Sensortec BMX055, which can be found here:

https://ae-bst.resource.bosch.com/media/ tech/media/datasheets/BST-BMX055-DS000-02.pdf

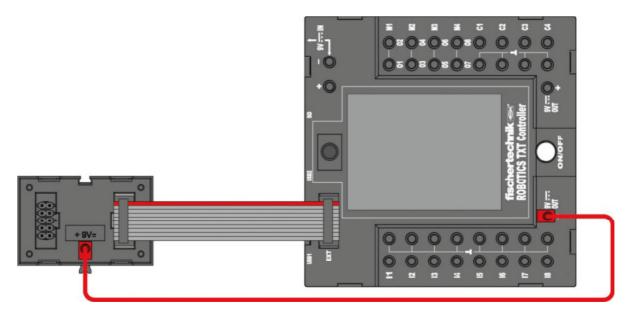


Fig.1: Connection of the fischertechnik 3-in-1 absolute-orientation sensor to the ROBOTICS TXT Controller.

Specifications:

- Integrated 3-axis gyrosensor / 3-axis acceleration sensor
- resolution: up to 12 bit
- measurement range acceleration: +-2/+-4/+-8/+-16g
- measurement range gyroscope: +-125/+-245/+-500/+-1000/+-2000°/s
- sample rate 1k/s
- I²C-port



I²C addresses of the devices

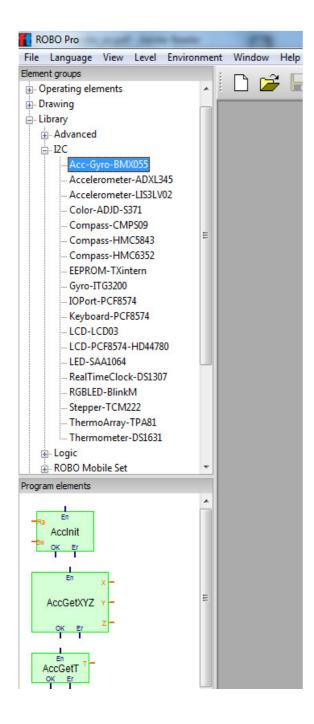
Acceleration sensor: 0x18

Gyroscope: 0x68

Geomagnetic sensor: 0x10

Assignment in ROBOPro (Version 4.2.4)

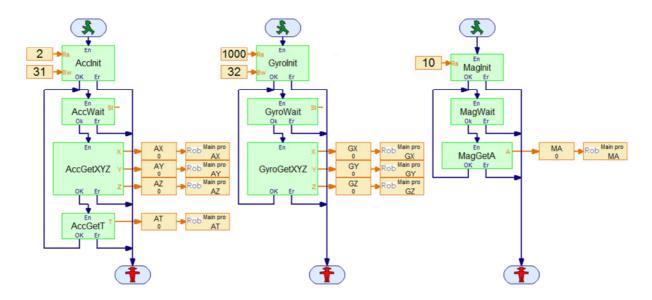
The three units of the 3-in-1 sensor have to be assigned independently in ROBOPro. For each sensor unit, there are three important blocks, which have to be used in order to obtain sensor values. They are availbale as subprograms in the element groups – Library – I2C – BMX055



On the one hand, these are the initialization blocks, which have to be called at the beginning of the program and on the other hand, the waiting blocks and the actual reading blocks, which have to be called continuously. These blocks can be found under 'Library->I2C->Acc-Gyro-BMX055'. In case of the acceleration sensor, these blocks are called 'AccInit', 'AccWait' and 'AccGetXYZ'.The gyroscope can be functions assigned by the 'GyroInit', 'GyroWait' and 'GyroGetXYZ'. The functions of the geomagnetic sensor are called 'MagWait' 'MagInit', 'MagGetA'. The initialization blocks are also used to configure the sensor units. Thereby, it is possible to set the bandwidth and the range of the sensor.



A typical configuration can be seen in the example program 'Acc-Gyro-BMX055.rpp', which can be seen in the figure below.



This sample is available in the folder ROBOPro\Library\I2C\Acc-Gyro-BMX055.rpp

The program reads all the values from the sensor and displays them in download mode on the display of the TXT Controller.





FT-T-KN 2019-10-23

ArtNr. part. no.	167358	
Bezeichnung name	Umweltsensor BME 680 Environmental-sen- sor BME680	
Abmessungen dimensions:	45x30x15mm	
Gewicht weight:	14,2g	
Spannungsver- sorgung Supply voltage:	9 VDC	

Signal: I2C-Schnittstelle über 10-polige Stiftleiste

Signal: I2C-port 10-pole male connector

Anschlüsse: rot=9VDC, grün=Masse, Schwarz=Signal connection: red=9VDC, green=ground, black=signal

Messwerte: measured values:

Lufttemperatur (-40 - +85°C) air temperature (-40 - +85°C)

Luftdruck (300-1100hPa) air pressure (300-1100hPa

Luftfeuchtigkeit 0-100% r. H. humidity 0-100% r. H.

Luftqualität, Messung durch Gassensor, Auswertung nach Indoor air quality (IAQ) air quality (measurement with gas sensor, evaluation according to Indoor air quality (IAQ)

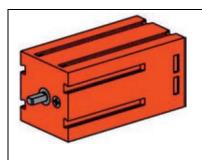
IAQ Index	Air Quality
0 – 50	$good^{10}$
51 – 100	average
101 – 150	little bad
151 – 200	bad
201 – 300	worse ²
301 – 500	very bad

Weitere Details siehe Datenblatt Bosch BME680 Further details see data sheet Bosch BME680



FT-T-KN 12.05.2020

Datenblatt Encodermotor 24V Art.-Nr. 168988 Datasheet Encoder motor 24V Art. No. 168988



Maße/dimensions: 65x30x30mm

Abtriebswelle/output shaft: D=4mm, L=7,5mm, 2 Abflachungen je 0,7mm/ 2 bevels 0.7mm each

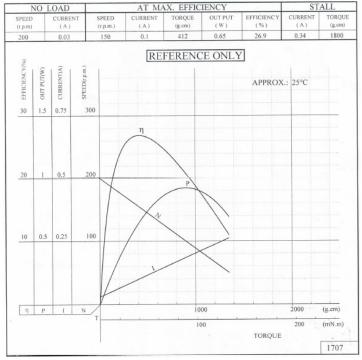
Stromversorgung: 24VDC über 2 fischertechnik Anschlussbuch-

sen D=2,5mm/

Power supply: 24VDC with 2 fischertechnik connection sock-

etsD=2.5mm

Motordaten/motor data:



Encoderdaten/encoder data:

Quadraturencoder, Stromversorung/power supply 24VDC Signal: Quadratur Encoder, Push-Pull Output (0/24V), max. 10mA Frequenz/frequency: max 1kHz.

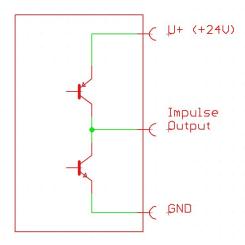
Anschlüsse/connector: 4-pol Stiftleiste, passendes Kabel/fitting cable: Art.No. 119785 rot/red=+24V, grün/green=0V, schwarz/black=Puls1, gelb/yellow=Impuls2



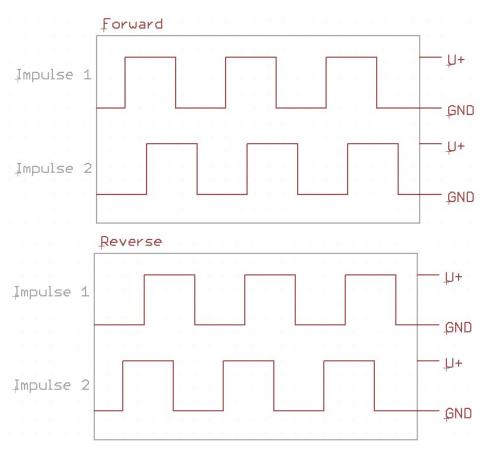


Ersatzschaltbild eines 24V Encoder-Ausgangs (2 pro Motor)

Equivalent circuit diagram of 24V encoder output (2 per motor)



Ausgangssignal des 24V-Encoders für verschiedene Drehrichtungen. Output signal of 24V-encoder for different directions of rotation





BME680

Low power gas, pressure, temperature & humidity sensor



BME680 - Datasheet

Document revision 1.0

Document number BST-BME680-DS001-00

Technical reference code(s) 1 277 340 511

Notes Data and descriptions in this document are subject to change without

notice. Product photos and pictures are for illustration purposes only and

may differ from the real product appearance.



BME680

Low power gas, pressure, temperature & humidity sensor

The BME680 is a digital 4-in-1 sensor with gas, humidity, pressure and temperature measurement based on proven sensing principles. The sensor module is housed in an extremely compact metal-lid LGA package with a footprint of only $3.0 \times 3.0 \text{ mm}^2$ with a maximum height of 1.00 mm ($0.93 \pm 0.07 \text{ mm}$). Its small dimensions and its low power consumption enable the integration in battery-powered or frequency-coupled devices, such as handsets or wearables.

Typical applications

- · Indoor air quality
- · Home automation and control
- Internet of things
- Weather forecast
- GPS enhancement (e.g. time-to-first-fix improvement, dead reckoning, slope detection)
- Indoor navigation (change of floor detection, elevator detection)
- Outdoor navigation, leisure and sports applications
- Vertical velocity indication (rise/sink speed)

Target Devices

- Handsets such as mobile phones, tablet PCs, GPS devices
- Wearables
- Home weather stations
- Smart watches
- Navigation systems
- Gaming, e.g. flying toys
- IOT devices

Key features

Package
 3.0 mm x 3.0 mm x 0.93 mm metal lid LGA

Digital interface
 I²C (up to 3.4 MHz) and SPI (3 and 4 wire, up to 10 MHz)

Supply voltage
 V_{DD} main supply voltage range: 1.71 V to 3.6 V

 V_{DDIO} interface voltage range: 1.2 V to 3.6 V

• Current consumption 2.1 μA at 1 Hz humidity and temperature

 $3.1 \mu A$ at 1 Hz pressure and temperature

 $3.7~\mu\text{A}$ at 1 Hz humidity, pressure and temperature 0.09-12~mA for p/h/T/gas depending on operation mode

0.15 µA in sleep mode

• Operating range -40-+85 °C, 0-100% r.H., 300-1100 hPa

• Individual humidity, pressure and gas sensors can be independently enabled/disabled

The product is RoHS compliant, halogen-free, MSL1

Key parameters for gas sensor

• Response time $(\tau_{33-63\%})$ < 1 s (for new sensors)

• Power consumption < 0.1 mA in ultra-low power mode

Output data processing direct indoor air quality (IAQ) index output

Key parameters for humidity sensor

• Response time $(\tau_{0-63\%})$ ~8 s

Accuracy tolerance ±3% r.H.
Hysteresis ±1.5% r.H.

Key parameters for pressure sensor

RMS Noise
 0.12 Pa, equiv. to 1.7 cm

• Offset temperature coefficient ±1.3 Pa/K, equiv. to ±10.9 cm at 1 °C temperature change

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1. Specification

If not stated otherwise,

- all values are valid over the full voltage range,
- all minimum/maximum values are given for the full accuracy temperature range
- minimum/maximum values of drifts, offsets and temperature coefficients are ±3σ values over lifetime,
- typical values of currents and state machine timings are determined at 25 °C,
- minimum/maximum values of currents are determined using corner lots over complete temperature range, and
- minimum/maximum values of state-machine timings are determined using corner lots over 0-+65 °C temperature range.

Besides the general electrical specifications, the following tables are separated for the gas, pressure, humidity and temperature functions of the BME680.

1.1 General Electrical Specification

Table 1: Electrical parameter specification

OPERATING CONDITIONS BME680						
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage Internal Domains ¹	V_{DD}	ripple max. 50 mVpp	1.71	1.8	3.6	V
Supply Voltage I/O Domain	V_{DDIO}		1.2	1.6	3.6	V
Sleep current	I _{DDSL}			0.15	1	μΑ
Standby current (inactive period of normal mode)	IDDSB			0.29	0.8	μΑ
Current during humidity measurement	I _{DDH}	Max value at 85 °C		340	450	μΑ
Current during pressure measurement	I _{DDP}	Max value at -40 °C		714	849	μΑ
Current during temperature measurement	I _{DDT}	Max value at 85 °C		350		μΑ
Start-up time	t _{startup}	Time to first communication after both $V_{DD} > 1.58 \text{ V}$ and $V_{DDIO} > 0.65 \text{ V}$			2	ms
Power supply rejection ratio (DC)	PSRR	full V _{DD} range			±0.01 ±5	%r.H./V Pa/V
Standby time accuracy	$\Delta t_{\text{standby}}$			±5	±25	%

Document number: BST-BME680-DS001-00 Revision_1.0_072017

 $^{^1}$ The power efficiency, performance and heat dissipation scales with the applied supply voltage. The BME680 is optimized for 1.8 V.

1.2 Gas sensor specification

Table 2 lists the gas sensor specification. All the parameters are deduced from lab measurements under controlled environmental conditions, which are compliant to the ISO16000-29 standard "Test methods for VOC detectors". Detailed procedure to measure the gas sensor is available in the Application Note: Measurement Instructions for Lab Environment.

Referring to Chapter 4, a software solution (BSEC: Bosch Software Environmental Cluster) is available for the BME680. The software is carefully engineered to seamlessly work with the 4-in-1 integrated sensors inside the BME680. Based on an intelligent algorithm, the BSEC provides an indoor air quality (IAQ) output. In principle, this output is in an index that can have values between 0 and 500 with a resolution of 1 to indicate or quantify the quality of the air available in the surrounding. Table 4 lists the IAQ system specification. The detailed classification and color coding of the IAQ index is described in Table 4. Furthermore, the BSEC solution supports different operation modes for the gas sensor to address the necessary power budget and update rate requirements of the end-application.

Unless mentioned otherwise, the specifications are deduced from new sensors that have been operated for at least five days mainly in ambient air and consequently have the same history (i.e. same power mode and exposed to the same environment).

Besides ethanol (EtOH) as a target test gas, the sensors are also tested with breath-VOC (b-VOC). The b-VOC mixture, as listed in Table 5, represents the most important compounds in an exhaled breath of healthy humans. The values are derived from several publications on breath analysis studies. The composition does not contain species which would chemically react to ensure that the mixture is stable for at least 6 months. Furthermore, the composition is also limited to species which can be manufactured in one mixture.

Table 2: Gas sensor parameter specification

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operational range ¹			-40		85	°C
Operational range			10		95	% r.H.
Supply Current during heater operation	I _{DD}	Heater target temperature 320 °C, constant operation (V _{DD} ≤ 1.8 V, 25°C)	9	12	13	mA
Peak Supply Current	I _{Peak}	Occurs within first ms of switching on the hotplate	15	17	18	mA
Average Supply		Ultra-low power mode		0.09		mA
Current	$I_{DD,IAQ}$	Low power mode		0.9		mA
$(V_{DD} \le 1.8 \text{ V}, 25^{\circ}\text{C})$		Continuous mode		12		mA
	τ33-63%	Ultra-low power mode		92		s
Response time ² (brand-new sensors)	τ33-63%	Low power mode		1.4		S
(arama non concerc)	τ33-63%	Continuous mode		0.75		s
Resolution of gas sensor resistance measurement			0.05	0.08	0.11	%
Noise in gas sensor resistance (RMS)	N _R			1.5		%

¹ The sensors are electrically operable within this range. Actual performance may vary

² Response time of unsoldered, brand-new sensors extracted from the sensors' resistance change in response to a 0.6–60 ppm step of EtOH and a 0.5–15 ppm step of b-VOC at 20 °C, 50% r.H. and atmospheric pressure.

Table 3: IAQ system parameter specification³

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Accuracy status ⁴	AX_{IAQ}	Android compatible	0		3	
IAQ Resolution	IAQ _{rs}			1		
IAQ Range	IAQ _{rg}		0		500	
Sensor-to-sensor deviation ⁵	IAQ _{S2S}	All operation modes		±15% ±15		
Durability to	IAQ _{S2S}	Sensor-to-sensor deviation		±15% ±15		
siloxanes ^{6,7,8}	IAQ _{drift}	Drift at low & high concentrations		±1% ±4		

Table 4: Indoor air quality (IAQ) classification and color-coding9

IAQ Index	Air Quality
0 – 50	good ¹⁰
51 – 100	average
101 – 150	little bad
151 – 200	bad
201 – 300	worse ²
301 – 500	very bad

Table 5: bVOC mixture with Nitrogen as carrier gas

Molar fraction	Compound	Production tolerance	Certified accuracy
5 ppm	Ethane	20 %	5 %
10 ppm	Isoprene /2-methyl-1,3 Butadiene	20 %	5 %
10 ppm	Ethanol	20 %	5 %
50 ppm	Acetone	20 %	5 %
15 ppm	Carbon Monoxide	10 %	2 %

³ IAQ parameters only apply for the combination of BME680 together with the Bosch Software Environmental Cluster (BSEC) solution (available separately, see Chapter 4)

⁴ The accuracy status is equal to zero during the power-on stabilization times of the sensor and is equal to 3 when the sensor achieves best performance

⁵ Tested with 0.6–90 ppm of EtOH at 5–40 °C, 20–80% r.H. and atmospheric pressure. Condition is valid after the calibration period of the BSEC algorithm. ⁶ Siloxanes are present in a typical indoor environment and can in principle perturb the metal-oxide-based gas sensor performance.

⁷ 220 hours of 700 mg/m³ of octamethylcyclotetrasiloxane (D4) in ambient conditions (i.e. 20 °C and 50% r.H.) simulates the amount of siloxanes in a typical indoor environment over more than 10 years.

⁸ Tested with 0.5–15 ppm of b-VOC at 20 °C and 50% r.H. using continuous operation mode for 220 hours of 700 mg/m³ of octamethylcyclotetrasiloxane (D4).

⁹ According to the guidelines issued by the German Federal Environmental Agency, exceeding 25 mg/m³ of total VOC leads to headaches and further neurotoxic impact on health.

 $^{^{10}}$ The BSEC software auto-calibrates the low and high concentrations applied during testing to IAQ of 25 and 250, respectively.

1.3 Humidity sensor specification

Table 6: Humidity parameter specification

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating Dangell			-40	25	85	°C
Operating Range ¹¹			0		100	% r.H.
Full acquire ou range			0		65	°C
Full accuracy range			10		90	% r.H.
Supply Current	Ідд,н	1 Hz forced mode, temperature and humidity measurement		2.1	2.8	μΑ
Absolute Accuracy	Ан	20–80 % r.H., 25 °C, including hysteresis		±3		% r.H.
Hysteresis ¹²	Нн	10→90→10 % r.H., 25°C		±1.5		% r.H.
Nonlinearity ¹³	NL _H	10→90 % r.H., 25°C		1.7		% r.H.
Response time to complete 63% of step ¹⁴	τ ₀ -63%	N_2 (dry) \rightarrow 90 % r.H., 25°C		8		S
Resolution	Rн			0.008		% r.H.
Noise in humidity (RMS)	N _H	Highest oversampling		0.01		% r.H.
Long-term stability	ΔH_{stab}	10–90 % r.H., 25°C		0.5		% r.H./ year

¹¹ When exceeding the operating range (e.g. for soldering), humidity sensing performance is temporarily degraded and reconditioning is recommended as described in Section 7.7. Operating range only for non-condensing environment.

¹² For hysteresis measurement the sequence 0→10→30→50→70→90→70→50→30→10 % r.H. is used. The hysteresis is defined as the maximum difference between measurements at of

the same humidity up / down branch and the averaged curve of both branches.

13 Non-linear contributions to the sensor data are corrected during the calculation of the relative humidity by the compensation formulas described in Section 3.5.

14 The air-flow in direction to the vent-hole of the device has to be dimensioned in a way that a sufficient air exchange inside to outside will be possible. To observe effects on the response time-scale of the device an air-flow velocity of approximately 1 $\mbox{m/s}$ is needed.

1.4 Pressure sensor specification

Table 7: Pressure parameter specification

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating temperature	T _A	operational	-40	25	85	°C
range	IA	full accuracy	0		65	O
Operating pressure range	Р	full accuracy	300		1100	hPa
Supply current	I _{DD,LP}	1 Hz forced mode, pressure and temperature, lowest power		3.1	4.2	μА
Temperature coefficient	TCO₽	25-40 °C, 900 hPa		±1.3		Pa/K
of offset ¹⁵		20 10 0,000 0		±10.9		cm/K
Absolute accuracy pressure	$A_{p, full}$	300–1100 hPa 0–65°C		±0.6		hPa
Relative accuracy	A _{rel}	700-900hPa, 25-40 °C, at constant humidity		±0.12		hPa
pressure	A _{rel}	900–1100hPa 25–40°C, at constant humidity		±0.12		hPa
Resolution of pressure output data	R _P	Highest oversampling		0.18		Pa
		Full bandwidth, highest		1.4		Pa
Noise in pressure	$N_{P,fullBW}$	oversampling		11		cm
		Reduced bandwidth, highest		0.2 1.7		Pa
Solder drift		oversampling	-0.5	1.7	+2.0	cm hPa
	_	Minimum solder height 50µm	-0.5		T2.U	
Long-term stability ¹⁶	P _{stab}	per year		±1.0		hPa
Possible sampling rate	f _{sample_P}	Lowest oversampling, see chapter 3.3.2	157	182		Hz

 $^{^{15}}$ When changing temperature from 25 °C to 40 °C at constant pressure / altitude, the measured pressure / altitude will change by (15×TCO_P). 16 Long-term stability is specified in the full accuracy operating pressure range 0–65 °C

1.5 Temperature sensor specification

Table 8: Temperature parameter specification

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating temperature range	TA	operational	-40	25	85	°C
Supply current	I _{DD,T}	1 Hz forced mode, temperature measurement only		1.0		μΑ
Absolute accuracy	Ат,25	25 °C		±0.5		°C
temperature ¹⁷	A _{T,full}	0–65 °C		±1.0		°C
Output resolution	R_T	API output resolution		0.01		°C
RMS noise	Nτ	Lowest oversampling		0.005		°C

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¹⁷ Temperature measured by the internal temperature sensor. This temperature value depends on the PCB temperature, sensor element self-heating and ambient temperature and is typically above ambient temperature.

2. Absolute maximum ratings

The absolute maximum ratings are determined over the complete temperature range using corner lots. The values are provided in Table 9.

Table 9: Absolute maximum ratings

Parameter	Condition	Min	Max	Unit
Voltage at any supply pin	V_{DD} and V_{DDIO} pin	-0.3	4.25	V
Voltage at any interface pin		-0.3	V _{DDIO} + 0.3	V
Storage temperature	≤ 65% r.H.	-45	+85	°C
Pressure		0	20 000	hPa
ESD	HBM, at any pin		±2	kV
200	Machine model		±200	V
Condensation	No power supplied	Allo		

3. Sensor usage

3.1 Sensor modes

The sensor supports low-level power modes: sleep and forced mode. These modes can be selected using the *mode*<1:0> control register (see Section 5.3.1.3). The key differences between the modes are summarized in Table 10.

After a power-up sequence, the sensor automatically starts in sleep mode. If the device is currently performing a measurement, execution of mode switching commands is delayed until the end of the currently running measurement period. It is important to note that, further mode change commands or other write commands to the control registers are ignored until the mode change command has been executed. All control registers should be set to the desired values before writing to the mode register.

Operation mode	mode<1:0>	Key features
Sleep	00	No measurements are performedMinimal power consumption
Forced mode	01	 Single TPHG cycle is performed Sensor automatically returns to sleep mode afterwards Gas sensor heater only operates during gas measurement

Table 10: Low-level operation modes

In forced mode, temperature, pressure, humidity and gas conversion are performed sequentially. Such a measurement cycle is abbreviated as TPHG (Temperature, Pressure, Humidity and Gas) in the following descriptions. Up to 10 temperature setpoints and heating durations for the gas sensor hot plate can be stored in the sensor registers. In the following, these setpoints and the corresponding measurements are identified as $G_0 - G_9$. Figure 1 illustrates the handling of these measurement sequences and the gas sensor hot plate is heated for the forced mode.

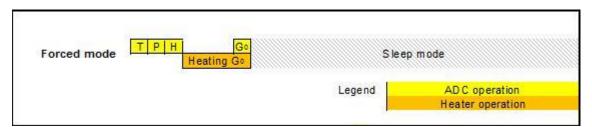


Figure 1: Sequence of ADC and gas sensor heater operation

3.2 Sensor configuration

3.2.1 Quick start

The sensor is configured by writing to a set of control registers (see Chapter 5 for a detailed list of all available registers and their descriptions). This section illustrates, with the help of a basic step-by-step example, how to configure the sensor for simple forced mode measurements with a single heater set-point. For a more detailed description of the measurement flow, please refer to Section 3.3.

In this example, the sensor will be configured to use 2x oversampling for its temperature measurements, 16x oversampling for the pressure signal, and 1x oversampling for humidity. Moreover, the gas sensor hot plate will be configured to be heated for 100 ms at 300 °C before the gas measurement is performed.

First, the user must configure the oversampling settings for temperature, pressure and humidity by setting the control registers $osrs_t<2:0>$ and $osrs_h<2:0>$, respectively. Supported settings range from 16x oversampling down to 0x, which is equivalent to skipping the corresponding sub-measurement. See Section 5.3.2 for further details.

- 1. Set humidity oversampling to 1x by writing 0b001 to osrs h<2:0>
- 2. Set temperature oversampling to 2x by writing 0b010 to osrs t<2:0>
- 3. Set pressure oversampling to 16x by writing 0b101 to osrs_p<2:0>

It is highly recommended to set first $osrs_h < 2:0 > followed by <math>osrs_t < 2:0 > and <math>osrs_p < 2:0 > in one write command (see Section 3.3).$

Next, the user shall set at least one gas sensor hot plate temperature set-point and heating duration. Up to 10 heating duration can be configured through the control registers $gas_wait_x<7:0>$, where x ranges from 0 to 9. See Section 5.3.3 for definition of register content. The corresponding heater set-points are stored in the registers $res_heat_x<7:0>$. Section 3.3.5 explains how to convert the target heater temperature, e.g. 300 °C, into a register code. For forced mode operation, the used heater set point is selected by setting the control register $nb_conv<3:0>$ to the heater profile to be used, e.g. to use $gas_wait_0<7:0>$ and $res_heat_0<7:0>$, $nb_conv<3:0>$ shall be set to 0x0. Finally, gas functionality shall be enabled by setting the run_gas_l bit to 1.

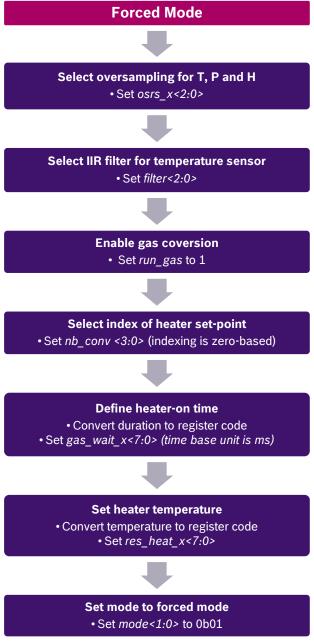
- 4. Set gas wait 0<7:0> to 0x59 to select 100 ms heat up duration
- 5. Set the corresponding heater set-point by writing the target heater resistance to res_heat_0<7:0>
- 6. Set nb conv<3:0> to 0x0 to select the previously defined heater settings
- 7. Set run gas I to 1 to enable gas measurements

Now, a single forced mode measurement with the above settings can be triggered by writing 0b01 to *mode<1:0>*. For more details on data readout, please see Section 5.3.1.3.

8. Set *mode<1:0>* to 0b01 to trigger a single measurement.

3.2.2 Sensor configuration flow

Picture 2 illustrates which control registers must be set. For details on the individual control registers, please refer to Chapter 5. Moreover, details on the measurement flow for the individual modes can be found in Section 3.3.



Picture 2: Sensor configuration flow

3.3 Measurement flow

Referring to Figure 1, the BME680 measurement period consists of a temperature, pressure and humidity measurement with selectable oversampling. Moreover, it contains a heating phase for the gas sensor hot plate as well as a measurement of the gas sensor resistance.

After the measurement period, the pressure and temperature data can be passed through an optional IIR filter, which removes short-term fluctuations. For humidity and gas, such a filter is not needed and has not been implemented.

3.3.1 Temperature measurement

Temperature measurement can be enabled or skipped. Skipping the measurement is typically not recommended since temperature information is used to compensate temperature influences in the other parameters. When enabled, several oversampling options exist. The temperature measurement is controlled by the *osrs_t<2:0>* setting which is detailed in Section 5.3.2.2. For the temperature measurement, oversampling is possible to reduce the noise. The resolution of the temperature data depends on the IIR filter (see Section 5.3.2.4) and the oversampling setting:

- When the IIR filter is enabled, the temperature resolution is 20 bit
- When the IIR filter is disabled, the temperature resolution is $16 + (osrs_t 1)$ bit, e.g. 18 bit when $osrs_t$ is set to '3'

3.3.2 Pressure measurement

Pressure measurement can be enabled or skipped. When enabled, several oversampling options exist. The pressure measurement is controlled by the osrs_p<2:0> setting which is detailed in Section 5.3.2. For the pressure measurement, oversampling is possible to reduce noise. The resolution of the pressure data depends on the IIR filter (see Section 5.3.2.4) and the oversampling setting:

- When the IIR filter is enabled, the pressure resolution is 20 bit
- When the IIR filter is disabled, the pressure resolution is $16 + (osrs_p 1)$ bit, e.g. 18 bit when $osrs_p$ is set to '3'

3.3.3 Humidity measurement

The humidity measurement can be enabled or skipped. When enabled, several oversampling options exist. The humidity measurement is controlled by the *osrs_h<2:0>* setting, which is described in detail in Section 5.3.2.1. For the humidity measurement, oversampling is possible to reduce noise. The resolution of the humidity measurement is fixed at 16 bit ADC output.

3.3.4 IIR filter

The environmental pressure is subject to many short-term changes, caused external disturbances. To suppress disturbances (e.g. slamming of door or wind blowing into the sensor) in the output data without causing additional interface traffic and processor work load, the BME680 features an internal IIR filter (see Section 5.3.2.4). It effectively reduces the bandwidth of the temperature and pressure output signals and increases the resolution of the output data to 20 bit, noting that the humidity and gas values inside the sensor does not fluctuate rapidly and does not require low pass filtering. The output of a next measurement step is filtered using the following formula:

$$x_{filt}[n] = \frac{x_{filt}[n-1] \cdot (c-1) + x_{ADC}}{c}$$

 $x_{filt}[n-1]$ is the data coming from the current filter memory, and x_{ADC} is the data coming from current ADC acquisition. $x_{filt}[n]$ denotes the new value of filter memory and the value that will be sent to the output registers.

The IIR filter can be configured to different filter coefficients, which slows down the response to the sensor inputs. Note that the response time with enabled IIR filter depends on the number of samples generated, which means that the data output rate must be known to calculate the actual response time.

When writing to the register *filter*, the filter is reset. The next ADC values will pass through the filter unchanged and become the initial memory values for the filter. If temperature or pressure measurements are skipped, the corresponding filter memory will be kept unchanged even though the output registers are set to 0x80000. When the previously skipped measurement is re-enabled, the output will be filtered using the filter memory from the last time when the measurement was not skipped. If this is not desired, please write to the filter register in order to re-initialize the filter.

3.3.5 Gas sensor heating and measurement

The operation of the gas sensing part of BME680 involves two steps:

- 1. Heating the gas sensor hot plate to a target temperature (typically between 200 °C and 400 °C) and keep that temperature for a certain duration of time.
- 2. Measuring the resistance of the gas sensitive layer.

Up to 10 different hot plate temperature set points can be configured by setting the registers $res_heat_x<7:0>$, where x=0...9. The internal heater control loop operates on the resistance of the heater structure. Hence, the user first needs to convert the target temperature into a device specific target resistance before writing the resulting register code into the sensor memory map.

The following code will calculate register code that to be written to *res_heat_x<7:0>*. Nevertheless, it is recommended to use the sensor API available on github (Chapter 4) for a friendlier user experience.

```
var1 = ((double)par_g1 / 16.0) + 49.0;
var2 = (((double)par_g2 / 32768.0) * 0.0005) + 0.00235;
var3 = (double)par_g3 / 1024.0;
var4 = var1 * (1.0 + (var2 * (double) target_temp));
var5 = var4 + (var3 * (double)amb_temp);
res_heat_x = (uint8_t)(3.4 * ((var5 * (4.0 / (4.0 + (double)res_heat_range)) * (1.0/(1.0 + (double)res_heat_val * 0.002)))) - 25));
```

where

- par_g1, par_g2, and par_g3 are calibration parameters,
- target temp is the target heater temperature in degree Celsius,
- amb temp is the ambient temperature (hardcoded or read from temperature sensor),
- *var5* is the target heater resistance in Ohm,
- res_heat_x is the decimal value that needs to be stored in register, where 'x' corresponds to the temperature profile number between 0 and 9,
- res_heat_range is the heater range stored in register address 0x02 <5:4>, and
- res_heat_val is the heater resistance correction factor stored in register address 0x00 (signed, value from -128 to 127).

Table 11: Variable names and register addresses for res heat x calculation

Variable name	Register address (LSB / MSB)
par_g1	0xED
par_g2	0xEB/0xEC
par_g3	0xEE
res_heat_range	0x02 <5:4>
res_heat_val	0x00

For each of the 10 temperature set-points, the heating duration must be specified. Referring to Figure 1, the heating phase starts after the temperature, pressure and humidity measurements are complete. This means there is no heating in parallel to these measurements, which is desirable to minimize undesired cross-influences between the various sensor components.

The heating duration is specified by writing to the corresponding *gas_wait_x<7:0>* control register. Heating durations between 1 ms and 4032 ms can be configured. In practice, approximately 20–30 ms are necessary for the heater to reach the intended target temperature.

3.4 Data readout

The procedure goes as follows, the new_data_x bit (see Section 5.3.5.1) can be checked to see if a new data is generated. If gas measurements are performed the gas_valid_r (see Section 5.3.5.5) and $heat_stab_r$ (see Section 5.3.5.6) status bits of the respectively field should be checked to ensure that the gas measurement was successful. If $heat_stab_r$ is zero, it indicates that either the heating time was not sufficient to allow the sensor to reach to configured target temperature or that the target temperature was too high for the sensor to reach.

After the uncompensated values of temperature, pressure and humidity have been read, the actual humidity, pressure and temperature need to be calculated using the compensation parameters stored in the device. Please refer to the BME6xy API for more details.

3.4.1 Gas resistance readout

Readout of gas resistance ADC value and calculation of gas resistance consists of 3 steps

- 1. Read gas ADC value (gas r) and gas ADC range (gas range r) (see Section 5.3.4)
- 2. Read range switching error from register address 0x04 <7:4> (signed 4 bit)
- 3. Convert ADC value into gas resistance in ohm

The conversion is done as follows:

```
var1 = (1340.0 + 5.0 * range_switching_error) * const_array1[gas_range];
gas_res = var1 * const_array2[gas_range] / (gas_r - 512.0 + var1);
```

3.5 Output compensation

The BME680 output consists of the ADC output values. However, each sensing element behaves differently. Therefore, the actual humidity, pressure and temperature must be calculated using a set of calibration parameters. This is implemented in the BME6xy API.

Table 12: List of gas ranges and corresponding constants used for the resistance calculation

gas_range	Constants (to	be integrated in the driver)
gas_range	const_array1	const_array2
0	1	8000000
1	1	400000
2	1	2000000
3	1	1000000
4	1	499500.4995
5	0.99	248262.1648
6	1	125000
7	0.992	63004.03226
8	1	31281.28128
9	1	15625
10	0.998	7812.5
11	0.995	3906.25
12	1	1953.125
13	0.99	976.5625
14	1	488.28125
15	1	244.140625

4. Software and use cases

4.1 BSEC software

BME680 sensor is intended to be used together with Bosch Software Environmental Cluster (BSEC) solution and BME6xy sensor API to unlock its full potential. The BSEC software features intelligent algorithms which enable use cases such as indoor-air-quality monitoring using the BME680.

Bosch Sensortec BSEC software is available as a closed source binary which will be made available via a Software License Agreement (SLA) on the Bosch Sensortec website (https://www.bosch-sensortec.com/bst/products/all_products/BSEC). Sensor API covers basic sensor communication and data compensation functions and is available as open-source code from Github (https://github.com/BoschSensortec/BME680 driver).

The key features of the hardware-software system are:

- Calculation of ambient air temperature outside of the device (e.g. phone)
- Calculation of ambient relative humidity outside of the device
- Calculation of indoor air quality (IAQ) level outside of the device

Moreover, the software algorithms handle humidity compensation, baseline as well as long-term drift correction of the gas sensor signal.

Different power modes for the gas sensor and corresponding data rates are supported by the software solution:

- Ultra low power (ULP) mode that is designed for battery-powered and/or frequency-coupled devices over extended
 periods of time. This mode features an update rate of 300 seconds and an average current consumption of <0.1 mA
- Low power (LP) mode that is designed for interactive applications where the indoor-air-quality is tracked and observed at a higher update rate of 3 seconds with a current consumption of <1 mA
- Continuous (CONT) mode provides an update rate of 1 Hz and shall only be used for use cases that incorporate very fast events or stimulus

BSEC power mode	Update rate	Average current consumption
Ultra-low power mode (ULP)	3.3 mHz	0.09 mA
Low power mode (LP)	0.33 Hz	0.9 mA
Continuous mode (for testing purposes only)	1 Hz	12 mA

Table 13: BSEC gas sensor power-modes

BSEC is available in two main variants called solutions: IAQ and ALL solution.

IAQ solution is intended for customers wishing to measure indoor-air-quality, temperature, humidity, and pressure in embedded devices. IAQ solution can be downloaded from the Bosch Sensortec website (https://www.bosch-sensortec.com/bst/products/all_products/BSEC).

ALL solution contains the same features as IAQ solution but also includes more complex ambient temperature and humidity estimation algorithms that will improve temperature and humidity performance in devices that contain many dynamic heat sources in their design. Such devices are, for example, smartphones containing displays, flashlights, large batteries and powerful microprocessors. As these advanced algorithms require tailoring to optimize them to a given customer design, please contact your local Bosch Sensortec representative for support.

The following table describes the available outputs of BSEC. Full descriptions of the outputs and the available interfaces are available in the integration guide shipped together with the BSEC software.

Table 14: BSEC outputs

	Included in		
Output	solution		Description
	IAQ ALL		
Raw pressure	✓	✓	Raw data from sensor API bypassed to BSEC output
Raw temperature	•	✓	Raw data from sensor API bypassed to BSEC output
Raw relative humidity	✓	✓	Raw data from sensor API bypassed to BSEC output
Raw gas resistance	•	✓	Raw data from sensor API bypassed to BSEC output
Sensor-compensated temperature	•	•	Temperature which is compensated for internal cross- influences caused by the BME sensor
Sensor-compensated relative humidity	•	•	Relative humidity which is compensated for internal cross- influences caused by the BME sensor
Ambient temperature		•	Ambient temperature after compensating the influence of device (where BME680 is integrated in) heatsources
Ambient relative humidity		•	Ambient relative humidity after compensating influence of device (where BME680 is integrated in) heatsources
IAQ (0-500)	•	✓	Indoor-air-quality
Accuracy status	•	✓	Accuracy status of IAQ, ambient termpature/humidity
Stabilization time status	•	•	Indicates if the sensor is undergoing initial stabilization during its first use after production
Run in status	✓	✓	Indicates when the sensor is ready after after switch-on

4.2 Indoor-air-quality

BME680 is a metal oxide-based sensor that detects VOCs by adsorption (and subsequent oxidation/reduction) on its sensitive layer. Thus, BME680 reacts to most volatile compounds polluting indoor air (one exception is for instance CO₂). In contrast to sensors selective for one specific component, BME680 is capable of measuring the sum of VOCs/contaminants in the surrounding air. This enables BME680 to detect e.g. outgassing from paint, furniture and/or garbage, high VOC levels due to cooking, food consumption, exhaled breath and/or sweating.

As a raw signal, BME680 will output resistance values and its changes due to varying VOC concentrations (the higher the concentration of reducing VOCs, the lower the resistance and vice versa). Since this raw signal is influenced by parameters other than VOC concentration (e.g. humidity level), the raw values are transformed to an indoor air quality (IAQ) index by smart algorithms inside BSEC.

The IAQ scale ranges from 0 (clean air) to 500 (heavily polluted air). During operation, the algorithms automatically calibrate and adapt themselves to the typical environments where the sensor is operated (e.g., home, workplace, inside a car, etc.). This automatic background calibration ensures that users experience consistent IAQ performance. The calibration process considers the recent measurement history (typ. up to four days) to ensure that IAQ ~ 25 corresponds to "typical good" air and IAQ ~ 250 indicates "typical polluted" air.

5. Global memory map and register description

5.1 General remarks

Communication with the device is performed by reading from and writing to registers. Registers have a width of 8 bits. If I²C is used, 8-bit addressing is utilized. If SPI is used, 7-bit address is only available for register access. For details on the interface, consult Chapter 6.

In SPI mode complete memory map is accessed using page 0 and page 1. Register spi_mem_page is used for page selection. After power-on, spi_mem_page is in its reset state and page 0 (0x80 to 0xFF) will be active. Page 1 (0x00 to 0x7F) will be active on setting spi_mem_page to 1.

Global memory map consists of calibration registers, control registers, data registers, status registers and reserved registers. There are, however, several registers which are reserved. Accordingly, they should not be written to and no specific value is guaranteed when they are read.

Table 15: Memory map page selection

Digital Interface	Register address range	Register spi_mem_page	Memory Page
I ² C	0x00 to 0xFF	Not Applicable	Not Applicable
SPI	0x80 to 0xFF	0 (default; power on state)	Page 0
SPI	0x00 to 0x7F	1	Page 1

5.2 Memory map

The memory map is given in Table 16: Memory map Table 16, noting that not all reserved registers are depicted.

Table 16: Memory map

	I ² C	SF	PI									
Register name	Adr	Adr	Pg	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit2	Bit 1	Bit 0	Reset state
status	73h	73h	1				spi_mem_page					01h
Reset	E0h	60h	0				reset<7	:0>				00h
ld	D0h	50h	0				chip_id<	7:0>				61h
Config	75h	75h	1					filter<2:0>			spi_3w_en	00h
Ctrl_meas	74h	74h	1		osrs_t<2:0>		o	srs_p<2:0>		mode	<1:0>	00h
Ctrl_hum	72h	72h	1		spi_3w_int_en					osrs_h<2:0>		00h
Ctrl_gas_1	71h	71h	1				run_gas		nb_cor	nv<3:0>		00h
Ctrl_gas_0	70h	70h	1					heat_off				00h
Gas_wait_x	6Dh64h	6Dh64h	1		gas_wait_9<7:0> downto gas_wait_0<7:0>					00h		
Res_heat_x	63h5Ah	63h5Ah	1		res_heat_9<7:0> downto res_heat_0<7:0>					00h		
Idac_heat_x	59h50h	59h50h	1		idac_heat_9<7:0> downto idac_heat_0<7:0>					00h		
gas_r_lsb	2Bh	2Bh	1	gas	gas_r<1:0> gas_valid_r heat_stab_r gas_range_r				00h			
gas_r_msb	2Ah	2Ah	1		gas_r<9:2>					00h		
hum_lsb	26h	26h	1		hum_lsb<7:0>					00h		
hum_msb	25h	25h	1		hum_msb<7:0>				80h			
temp_xlsb	24h	24h	1		tem	o_xlsb<7:4>		0	0	0	0	00h
temp_lsb	23h	23h	1		temp_lsb<7:0>				00h			
temp_msb	22h	22h	1		temp_msb<7:0>				80h			
press_xlsb	21h	21h	1		press_xlsb<7:4> 0 0 0 0				00h			
press_lsb	20h	20h	1		press_lsb<7:0>					00h		
press_msb	1Fh	1Fh	1		press_msb<7:0>				80h			
eas_status_0	1Dh	1Dh	1	new_data_0	gas_measuring	measuring			gas_meas_i	ndex_0<3:0>		00h

Color/Type
Do not change
Read only
Read only
Read/write

5.3 Register description

5.3.1 General control registers

5.3.1.1 SPI 3 wire interrupt enable - spi_3w_int_en

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_hum	0x72	spi_3w_int_en <6>	New data interrupt can be enabled if the device is in SPI 3 wire mode and $pi_3w_int_en=1$. The new data interrupt is then indicated on the SDO pad.

5.3.1.2 SPI 3 wire enable - spi_3w_en

Register Name	Address	Content <bit position=""></bit>	Description
config	0x75	spi_3w_en<0>	Enable SPI 3 wire mode

5.3.1.3 Mode Selection - mode

The operation modes of the sensor can be controlled by the register mode as specified below.

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_meas	0x74	mode<1:0>	Select sensor power mode as shown in the following table

mode<1:0>	Mode
00	Sleep mode
01	Forced mode

5.3.1.4 SPI memory map page selection – spi_mem_page

In SPI mode complete memory page is accessed using page 0 & page 1. Register spi_mem_page is used for page selection. After power-on, spi_mem_page is in its reset state and page 0(0x00 to 0x7F) will be active. Page1 (0x7F to 0xFF) will be active on setting spi_mem_page . Please refer Table 15 for better understanding.

Register Name	Address	Content <bit position=""></bit>	Description
status	0x73(Page 0/1)	spi_mem_page <4>	Selects memory map page in SPI mode

5.3.1.5 Reset - reset

Writing 0xB6 to this register initiates a soft-reset procedure, which has the same effect like power-on reset. The default value stored in this register is 0x00.

Register Name	Address	Content <bit position=""></bit>	Description
reset	0x60 (Page 0 in SPI mode) 0xE0 in I ² C	reset<7:0>	Resets the device

5.3.1.6 Chip id - chip_id

Register Name	er Name Address Content <bit position=""></bit>		Description
Id	0x50(Page 0 in SPI mode)	chip_id<7:0>	Chip id of the device
	0xD0 in I ² C		

5.3.2 Temperature, pressure and relative humidity control registers

5.3.2.1 Humidity sensor over sampling control – osrs_h

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_hum	0x72	osrs_h<2:0>	Controls over sampling setting of humidity
			sensor as described in the following table

osrs_h<2:0>	Humidity oversampling
000	Skipped (output set to 0x8000)
001	oversampling ×1
010	oversampling ×2
011	oversampling ×4
100	oversampling ×8
101, Others	oversampling ×16

5.3.2.2 Over sampling setting – Temperature data – osrs_t

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_meas	0×74	osrs_t<7:5>	Temperature oversampling settings as shown in the following table

osrs_t<2:0>	Temperature oversampling
000	Skipped (output set to 0x8000)
001	oversampling ×1
010	oversampling ×2
011	oversampling ×4
100	oversampling ×8
101, Others	oversampling ×16

5.3.2.3 Over sampling setting – Pressure data – osrs_p

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_meas	0x74	osrs_p<4:2>	Pressure oversampling settings as shown in the following table

osrs_p<2:0>	Pressure oversampling
000	Skipped (output set to 0x8000)
001	oversampling ×1
010	oversampling ×2
011	oversampling ×4
100	oversampling ×8
101, Others	oversampling ×16

5.3.2.4 IIR filter control - filter

IIR filter applies to temperature and pressure data but not to humidity and gas data. The data coming from the ADC are filtered and then loaded into the data registers. The temperature and pressure result registers are updated together at the same time at the end of the measurement. IIR filter output resolution is 20 bits. The result registers are reset to value 0x80000 when the temperature and/or pressure measurements have been skipped (osrs_x="000"). The appropriate filter memory is kept unchanged (the value from the last measurement is kept). When the appropriate OSRS register is set back to nonzero, then the first value stored to the result registers are filtered.

Register Name	Address	Content <bit position=""></bit>	Description
config	0x75	filter<4:2>	IIR filter settings as shown in the following table

filter<2:0>	Filter coefficient
000	0
001	1
010	3
011	7
100	15
101	31
110	63
111	127

5.3.3 Gas control registers

The sensor can have 10 programmable gas sensor heater set-points. A set-point consists of a target heater resistance, heater-on time and optionally an initial heater current.

5.3.3.1 Heater current - idac_heat_x

BME680 contains a heater control block that will inject enough current into the heater resistance to achieve the requested heater temperature. There is a control loop which periodically measures heater resistance value and adapts the value of current injected from a DAC.

The heater operation could be speeded up by setting an initial heater current for a target heater temperature by using register $idac_heat_x<7:0>$. This step is optional since the control loop will find the current after a few iterations anyway. The current injected to the heater in mA can be calculated by: $(idac_heat_7_1 + 1) / 8$, where $idac_heat_7_1$ is the decimal value stored in $idac_heat<7:1>$ (unsigned, value from 0 to 127).

Heater set- point	Register name	Address	Content	Description
09	idac_heat_x x is from 0 to 9	0x500x59	idac_heat_x<7:0> x is from 0 to 9	idac_heat of particular heater set point

5.3.3.2 Target heater resistance - res_heat_x

Target heater resistance is programmed by user through *res_heat_x*<7:0> registers. The definition of *res_heat_x* is given in Section 3.3.5.

Heater set-point	Register name	Address	Content	Description
09	res_wait_x x is from 0 to 9	0x5A0x63	res_heat_x<7:0> x is from 0 to 9	Decimal value that needs to be stored for achieving target heater resistance

5.3.3.3 Gas Sensor wait time - gas_wait_x

Referring to Figure 1, the time between the beginning of the heat phase and the start of gas sensor resistance conversion depends on *gas_wait_x* setting as mentioned below.

Heater set-point	Register name	Address	Content	Description
09	gas_wait_x x is from 0 to 9	0x640x6D	gas_wait_x<5:0> x is from 0 to 9	64 timer values with 1 ms step sizes, all zeros means no wait
09	gas_wait_x x is from 0 to 9	0x640x6D	gas_wait_x<7:6> x is from 0 to 9	Please refer to the table below for settings

gas_wait_x<7:6>	Gas sensor wait time multiplication factor
00	1
01	4
10	16
11	64

5.3.3.4 Heater off - heat_off

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_gas_0	0x70	heat_off <3>	Turn off current injected to heater by setting bit to
			one

5.3.3.5 Heater profile selection - nb_conv

 $\underline{\textit{nb_conv}}$ is used to select heater set-points of the sensor. The different heater set-points are described in the sections above.

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_gas_1	0x71	nb_conv<3:0>	Indicates index of heater set point that will be
			used in forced mode as describe in below table

nb_conv<3:0>	Heater profile set-point
0000	0
0001	1
0010	2
0011	3
0100	4
0101	5
0110	6
0111	7
1000	8
1001	9

5.3.3.6 Run Gas - run_gas

Register Name	Address	Content <bit position=""></bit>	Description
ctrl_gas_1	0x71	run_gas<4>	The gas conversions are started only in
			appropriate mode if run gas = '1'

5.3.4 Data registers

In this section, the data registers for the temperature, pressure, humidity and gas sensors are explained. Shadowing registers are utilized to buffer the data and to ensure stable data in case an update of the data registers occurs simultaneously with the serial interface reading out.

5.3.4.1 Pressure data

Register Name	Address	Content <bit position=""></bit>	Description
press_msb	0x1F	press_msb<7:0>	Contains the MSB part [19:12] of the raw pressure measurement output data.
press_lsb	0x20	press_lsb<7:0>	Contains the LSB part [11:4] of the raw pressure measurement output data
press_xlsb	0x21	press_xlsb<7:4>	Contains the XLSB part [3:0] of the raw pressure measurement output data. Contents depend on pressure resolution controlled by oversampling setting.

5.3.4.2 Temp data

Register Name	Address	Content <bit position=""></bit>	Description
temp_msb	0x22	temp_msb<7:0>	Contains the MSB part [19:12] of the raw temperature measurement output data.
temp_lsb	0x23	temp_lsb<7:0>	Contains the LSB part [11:4] of the raw temperature measurement output data.
temp_xlsb	0x24	temp_xlsb<7:4>	Contains the XLSB part [3:0] of the raw temperature measurement output data. Contents depend on temperature resolution controlled by oversampling setting.

5.3.4.3 Humidity data

Register Name	Address	Content <bit position=""></bit>	Description
hum_msb	0x25	hum_msb<7:0>	Contains the MSB part [15:8] of the raw humidity measurement output data.
hum_lsb	0x26	hum_lsb<7:0>	Contains the LSB part [7:0] of the raw humidity measurement output data.

5.3.4.4 Gas resistance data

Register Name	Address	Content <bit position=""></bit>	Description
gas_r_msb	0x2A	gas_r<7:0>	Contains the MSB part gas resistance [9:2] of the raw gas resistance.
gas_r_lsb	0x2B	gas_r<7:6>	Contains the LSB part gas resistance [1:0] of the raw gas resistance.

5.3.4.5 Gas resistance range

Register Name	Address	Content <bit position=""></bit>	Description
gas_r_lsb	0x2B	gas_range_r<3:0>	Contains ADC range of measured gas resistance.

5.3.5 Status registers

5.3.5.1 New data status

The measured data are stored into the output data registers at the end of each TPHG conversion phase along with status flags and index of measurement.

Register Name	Address	Content <bit position=""></bit>	Description
meas_status_0	0x1D	new_data_0<7>	New data flag

5.3.5.2 Gas measuring status

Measuring bit is set to "1" only during gas measurements, goes to "0" as soon as measurement is completed and data transferred to data registers. The registers storing the configuration values for the measurement (gas_wait_shared, gas_wait_x, res_heat_x, idac_heat_x, image registers) should not be changed when the device is measuring.

Register Name	Address	Content bit position>	Description
meas_status_0	0x1D	gas_measuring<6>	Gas measuring status flag

5.3.5.3 Measuring status

Measuring status will be set to '1' whenever a conversion (temperature, pressure, humidity and gas) is running and back to '0' when the results have been transferred to the data registers.

Register Name	Address	Content <bit position=""></bit>	Description
meas_status_0	0x1D	measuring<5>	Measuring status flag

5.3.5.4 Gas Measurement Index

User can program a sequence of up to 10 conversions by setting *nb_conv<3:0>*. Each conversion has its own heater resistance target but 3 field registers to store conversion results. The actual gas conversion number in the measurement sequence (up to 10 conversions numbered from 0 to 9) is stored in *gas_meas_index* register.

Register Name	Address	Content <bit position=""></bit>	Description
meas_status_0	0x1D	gas_meas_index_0<3:0>	Gas measurement index

5.3.5.5 Gas valid status

In each TPHG sequence contains a gas measurement slot, either a real one which result is used or a dummy one to keep a constant sampling rate and predictable device timing. A real gas conversion (i.e., not a dummy one) is indicated by the gas_valid_r status register.

Register Name	Address	Content <bit position=""></bit>	Description
gas_r_lsb	0x2B	gas_valid_r<5>	Gas valid bit

5.3.5.6 Heater Stability Status

Heater temperature stability for target heater resistance is indicated *heat_stab_x* status bits.

Register Name	Address	Content bit position>	Description
gas_r_lsb	0x2B	heat_stab_r<4>	Heater stability bit

6. Digital interfaces

The sensor supports the I²C and SPI digital interfaces, where it acts as a slave for both protocols. The I²C interface supports the Standard, Fast and High Speed modes. The SPI interface supports both SPI mode '00' (CPOL = CPHA = '0') and mode '11' (CPOL = CPHA = '1') in 4-wire and 3-wire configuration.

The following transactions are supported:

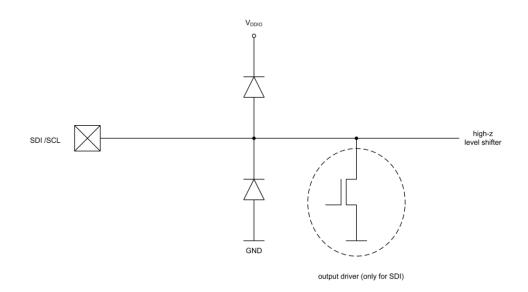
- Single byte write
- multiple byte write (using pairs of register addresses and register data)
- single byte read
- multiple byte read (using a single register address which is auto-incremented)

6.1 Interface selection

Interface selection is done automatically based on CSB (chip select) status. If CSB is connected to V_{DDIO}, the I²C interface is active. If CSB is pulled down, the SPI interface is activated. After CSB has been pulled down once (regardless of whether any clock cycle occurred), the I²C interface is disabled until the next power-on-reset. This is done in order to avoid inadvertently decoding SPI traffic to another slave as I²C data. Since the device startup is deferred until both V_{DD} and V_{DDIO} are established, there is no risk of incorrect protocol detection because of the power-up sequence used. However, if I²C is to be used and CSB is not directly connected to V_{DDIO} but is instead connected to a programmable pin, it must be ensured that this pin already outputs the V_{DDIO} level during power-on-reset of the device. If this is not the case, the device will be locked in SPI mode and not respond to I²C commands.

6.2 I2C Interface

For detailed timings, please review Table 18. All modes (standard, fast, high speed) are supported. SDA and SCL are not pure open-drain. Both pads contain ESD protection diodes to VDDIO and GND. As the devices does not perform clock stretching, the SCL structure is a high-Z input without drain capability.



Picture 3: SDI/SCK ESD schematic

The 7-bit device address is 111011x. The 6 MSB bits are fixed. The last bit is changeable by SDO value and can be changed during operation. Connecting SDO to GND results in slave address 1110110 (0x76); connection it to V_{DDIO} results in slave address 1110111 (0x77), which is the same as BMP280's I²C address. The SDO pin cannot be left floating; if left floating, the I²C address will be undefined.

The I²C interface uses the following pins:

• SCK: serial clock (SCL)

SDI: data (SDA)

SDO: Slave address LSB (GND = '0', V_{DDIO} = '1')

CSB must be connected to V_{DDIO} to select I²C interface. SDI is bi-directional with open drain to GND: it must be externally connected to V_{DDIO} via a pull up resistor. Refer to Chapter 7 for connection instructions.

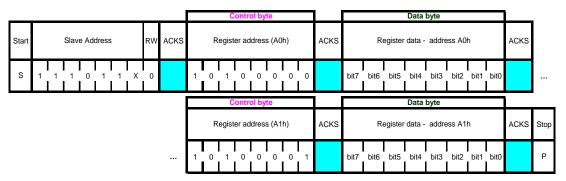
The following abbreviations will be used in the I²C protocol figures:

S Start
 P Stop

ACKS Acknowledge by slave
 ACKM Acknowledge by master
 NACKM Not acknowledge by master

6.2.1 I2C write

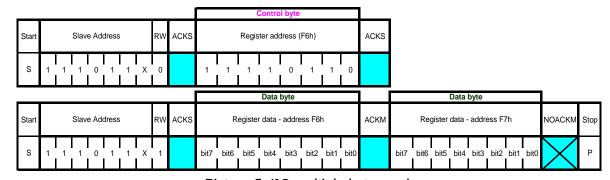
Writing is done by sending the slave address in write mode (RW = '0'), resulting in slave address 111011X0 ('X' is determined by state of SDO pin. Then the master sends pairs of register addresses and register data. The transaction is ended by a stop condition. This is depicted in Picture 4.



Picture 4: I²C multiple byte write (not auto-incremented)

6.2.2 I2C read

To be able to read registers, first the register address must be sent in write mode (slave address 111011X0). Then either a stop or a repeated start condition must be generated. After this the slave is addressed in read mode (RW = '1') at address 111011X1, after which the slave sends out data from auto-incremented register addresses until a NOACKM and stop condition occurs. This is depicted in Picture 5, where register 0xF6 and 0xF7 are read.



Picture 5: I2C multiple byte read

6.3 SPI interface

The SPI interface is compatible with SPI mode '00' (CPOL = CPHA = '0') and mode '11' (CPOL = CPHA = '1'). The automatic selection between mode '00' and '11' is determined by the value of SCK after the CSB falling edge.

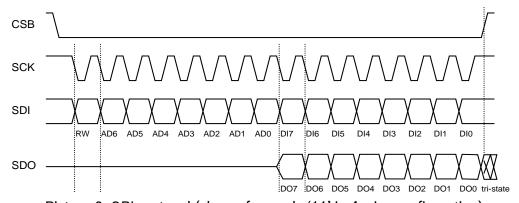
The SPI interface has two modes, namely 4-wire and 3-wire mode. However, the protocol is the same for both. The 3-wire mode is selected by setting '1' to the register spi3w_en. The pad SDI is used as a data pad in 3-wire mode.

The SPI interface uses the following pins:

- CSB: chip select, active low
- SCK: serial clock
- SDI: serial data input; data input/output in 3-wire mode
- SDO: serial data output; hi-Z in 3-wire mode

For more connection instructions, please refer to Chapter 7.

CSB is active low and has an integrated pull-up resistor. Data on SDI is latched by the device at SCK rising edge and SDO is changed at SCK falling edge. Communication starts when CSB goes to low and stops when CSB goes to high; during these transitions on CSB, SCK must be stable. The SPI protocol is shown in It is important to note that Picture 6. For timing details, please review Table 19.



Picture 6: SPI protocol (shown for mode '11' in 4-wire configuration)

It is important to note that in the SPI mode, only 7 bits of the register addresses are used; the MSB of register address is not used and replaced by a read/write bit (RW = '0' for write and RW = '1' for read). For example, address 0xF7 is accessed by using SPI register address 0x77. On the one hand, the byte 0x77 is transferred for write access, and on the other hand, the byte 0xF7 is transferred for read access.

6.3.1 SPI write

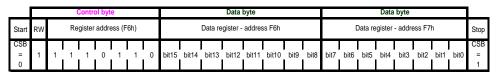
Writing is done by lowering CSB and sending pairs control bytes and register data. The control bytes consist of the SPI register address (= full register address without bit 7) and the write command (bit7 = RW = '0'). Several pairs can be written without raising CSB. The transaction is ended by a raising CSB. The SPI write protocol is depicted in Picture 7.

				Contr	ol byt	е				Data byte			Control byte				Data byte																
Start	RW		R	egiste	r addre	ess (F	4h)				Data re	gister -	addres	ss F4h			RW		Re	egister	addre	ess (F	5h)				Data r	egister	- adress	s F5h			Stop
CSB																																	CSB
=	0	1	1	1	0	1	0	0	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	0	1	1	1	0	1	0	1	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	=
0			1		1									I						1 1							I						1

Picture 7: SPI multiple byte write (not auto-incremented)

6.3.2 SPI read

Reading is done by lowering CSB and first sending one control byte. The control bytes consist of the SPI register address (= full register address without bit 7) and the read command (bit 7 = RW = '1'). After writing the control byte, data is sent out of the SDO pin (SDI in 3-wire mode); the register address is automatically incremented. The SPI read protocol is depicted in Picture 8.



Picture 8: SPI multiple byte read

6.4 Interface parameter specification

6.4.1 General interface parameters

Table 17: Interface parameters

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Input low level	V _{il_si}	V _{DDIO} =1.2 V to 3. 6V			20	%V _{DDIO}
Input high level	V _{ih_si}	V _{DDIO} =1.2 V to 3.6 V	80			%V _{DDIO}
Output low level I ² C	V _{ol_SDI}	V _{DDIO} =1.62 V, I _{ol} =3 mA			20	%V _{DDIO}
Output low level I ² C	V _{ol_SDI_1.2}	V _{DDIO} =1.20 V, I _{ol} =3 mA			23	%V _{DDIO}
Output low level SPI	V _{ol_SDO}	V _{DDIO} =1.62 V, I _{ol} =1 mA			20	%V _{DDIO}
Output low level SPI	Vol_SDO_1.2	V _{DDIO} =1.20 V, I _{ol} =1 mA			23	%V _{DDIO}
Output high level	V _{oh}	V _{DDIO} =1.62 V, I _{oh} =1 mA (SDO, SDI)	80			%V _{DDIO}
Output high level	V _{oh_1.2}	V _{DDIO} =1.20 V, I _{oh} =1 mA (SDO, SDI)	60			%V _{DDIO}
Pull-up resistor	R _{pull}	Internal CSB pull-up resistor to V _{DDIO}	70	120	190	kΩ
I ² C bus load capacitor	Сь	On SDI and SCK			400	pF

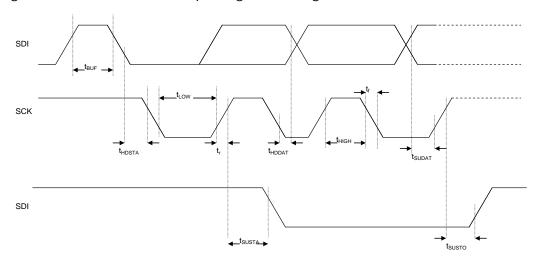
6.4.2 I2C timings

For I²C timings, the following abbreviations are used:

- "S&F mode" = standard and fast mode
- "HS mode" = high speed mode
- C_b = bus capacitance on SDA line

All other naming refers to I²C specification 2.1 (January 2000).

The I2C timing diagram is in Picture 9. The corresponding values are given in Table 18



Picture 9: I2C timing diagram

Table 18: I²C timings

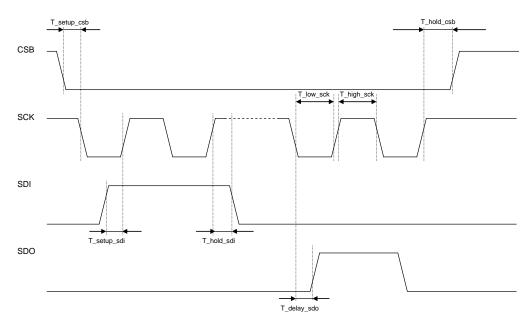
Parameter	Symbol	Condition	Min	Тур	Max	Unit
CDI cotun timo		S&F Mode	160			ns
SDI setup time	tsu;dat	HS mode	30			ns
SDI hold time	thd;dat	S&F Mode, $C_b \le 100$ pF S&F Mode, $C_b \le 400$ pF HS mode, $C_b \le 100$ pF HS mode, $C_b \le 400$ pF	80 90 18 24		115 150	ns ns ns ns
SCK low pulse	tLow	HS mode, C _b ≤100 pF V _{DDIO} = 1.62 V	160			ns
SCK low pulse	t _{LOW}	HS mode, C _b ≤100 pF V _{DDIO} = 1.2 V	210			ns

The above-mentioned I²C specific timings correspond to the following internal added delays:

- Input delay between SDI and SCK inputs: SDI is more delayed than SCK by typically 100 ns in Standard and Fast Modes and by typically 20 ns in High Speed Mode.
- Output delay from SCK falling edge to SDI output propagation is typically 140 ns in Standard and Fast Modes and typically 70 ns in High Speed Mode.

6.4.3 SPI timings

The SPI timing diagram is in Picture 10, while the corresponding values are given in Table 19. All timings apply both to 4-and 3-wire SPI.



Picture 10: SPI timing diagram

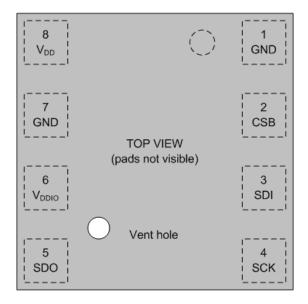
Table 19: SPI timings

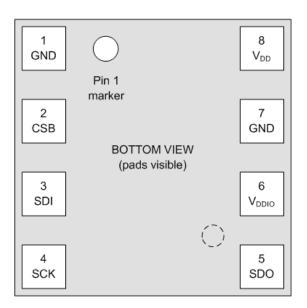
Parameter	Symbol	Condition	Min	Тур	Max	Unit
SPI clock i/p frequency	F_spi		0		10	MHz
SCK low pulse	T_low_sck		20			ns
SCK high pulse	T_high_sck		20			ns
SDI setup time	T_setup_sdi		20			ns
SDI hold time	T_hold_sdi		20			ns
SDO output delay	T_delay_sdo	25 pF load, V _{DDIO} =1.6 V min			30	ns
SDO output delay	T_delay_sdo	25 pF load, V _{DDIO} =1.2 V min			40	ns
CSB setup time	T_setup_csb		20			ns
CSB hold time	T_hold_csb		20			ns
SPI clock input frequency	F_spi		0	<u> </u>	10	MHz

7. Pin-out and connection diagram

7.1 Pin-out

The pin numbering of BME680 is performed in the untypical clockwise direction when seen in top view and counter-clockwise when seen in bottom view. Picture 11 and Table 20 give a detailed description and illustration of the input/output pins.





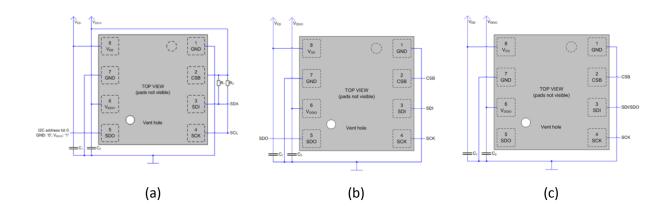
Picture 11: Top (left) and bottom (right) views of the chip with input/output pins

Table 20: Pin description

D:				Connection	n				
Pin	Name	I/O type	Description	SPI 4W	SPI 3W	I ² C			
1	GND	Supply	Ground	GND					
2	CSB	In	Chip select	CSB	CSB	V _{DDIO}			
3	SDI	In/Out	Serial data input	SDI	SDI/SDO	SDA			
4	SCK	In	Serial clock input	SCK	SCK	SCL			
5	SDO	In/Out	Serial data output	SDO	DO DNC				
6	V _{DDIO}	Supply	Digital / Interface supply	V _{DDIO}					
7	GND	Supply	Ground	GND					
8	V_{DD}	Supply	Analog supply	V_{DD}					

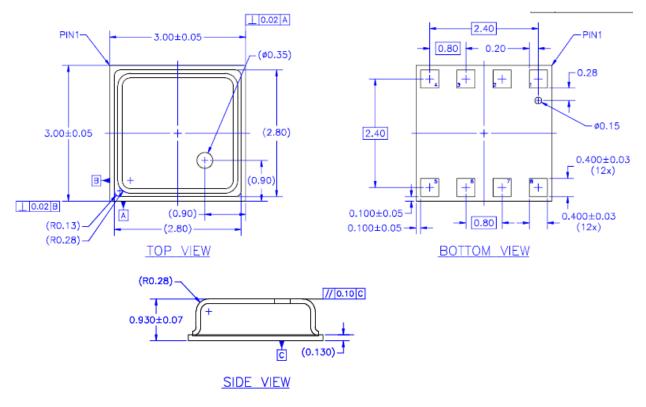
7.2 Connection diagrams

For the I^2C connection, it is recommended to use 100 nF for C_1 and C_2 . Moreover, the value for the pull-up resistors R_1 and R_2 should be based on the interface timing and the bus load; a normal value is 4.7 k Ω . Finally, a direct connection between CSB and V_{DDIO} is required. Similarly for the 4- and 3-wire SPI connections, it is suggested to use 100 nF for C_1 and C_2 .



Picture 12: Connection diagrams for (a) I²C, (b) 4-wire SPI, and (c) 3-wire SPI

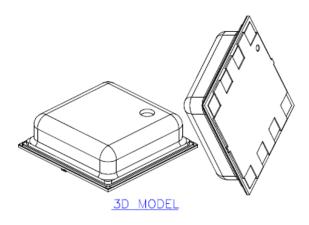
7.3 Package dimensions



- REFERENCE SPECIFICATIONS:

 A. AWW SPEC #001-0531-2234: PACKING OPERATION PROCEDURE.
 B. AWW SPEC #001-0519-2062: MARKING.
- ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994.

NOTES: UNLESS OTHERWISE SPECIFIED

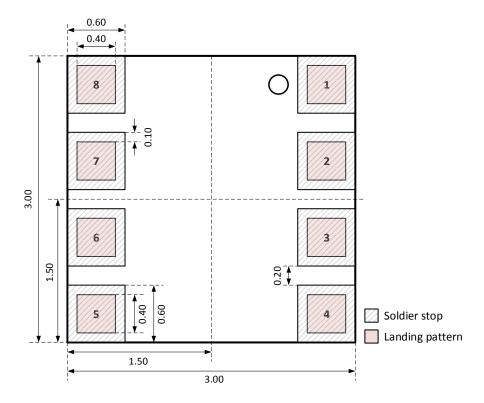


Picture 13: Package dimensions for top, bottom and side view

7.4 Landing pattern recommendation

For the design of the landing pattern, the dimensions shown in Picture 14: Recommended landing pattern (top view; dimensions are in milli-meters) are recommended. It is important to note that areas marked in red are exposed PCB metal pads.

- In case of a solder mask defined (SMD) PCB process, the land dimensions should be defined by solder mask openings. The underlying metal pads are larger than these openings.
- In case of a non-solder mask defined (NSMD) PCB process, the land dimensions should be defined in the metal layer. The mask openings are larger than these metal pads.



Picture 14: Recommended landing pattern (top view; dimensions are in milli-meters)

7.5 Marking

7.5.1 Mass production devices

Table 21: Marking of mass production parts

Marking	Symbol	Description
5 6 7 8 Vent 10 0 0 0	ccc	Lot counter: 3 alphanumeric digits, variable to generate mass production trace-code
hole CCC TL Pin 1 marker	Т	Product number: 1 alphanumeric digit, fixed to identify product type, T = "S" "S" is associated with the product BME680 (part number 1 277 340 511)
4 3 2 1	L	Sub-contractor ID: 1 alphanumeric digit, variable to identify sub-contractor (L = "P")

7.5.2 Engineering samples

Table 22: Marking of engineering samples

Marking	Symbol	Description
5 6 7 8 Vent O V V N	xx	Sample ID: 2 alphanumeric digits, variable to generate trace-code
hole CC	N	Eng. Sample ID: 1 alphanumeric digit, fixed to identify engineering sample, N = " * " or "e" or "E"
4 3 2 1 marker	СС	Counter ID: 2 alphanumeric digits, variable to generate trace-code

7.6 Soldering guidelines and reconditioning recommendations

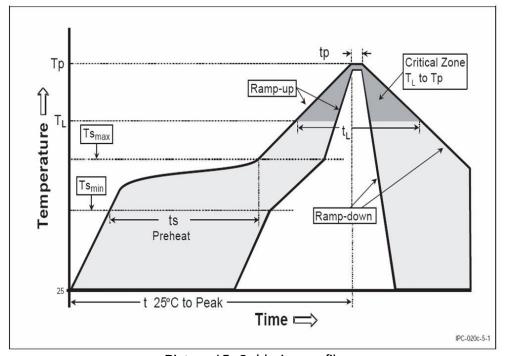
The moisture sensitivity level of the BME680 sensors corresponds to JEDEC Level 1, see also:

- IPC/JEDEC J-STD-020C "Joint Industry Standard: Moisture/Reflow Sensitivity Classification for non-hermetic Solid State Surface Mount Devices"
- IPC/JEDEC J-STD-033A "Joint Industry Standard: Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices"

The sensor fulfils the lead-free soldering requirements of the above-mentioned IPC/JEDEC standard, i.e. reflow soldering with a peak temperature up to 260°C. The minimum height of the solder after reflow shall be at least 50 μ m. This is required for good mechanical decoupling between the sensor device and the printed circuit board (PCB).

Profile Feature	Pb-Free Assembly	
Average Ramp-Up Rate (Ts _{max} to Tp)	3° C/second max.	
Preheat - Temperature Min (Ts _{min}) - Temperature Max (Ts _{max}) - Time (ts _{min} to ts _{max})	150 °C 200 °C 60-180 seconds	
Time maintained above: - Temperature (T _L) - Time (t _L)	217 °C 60-150 seconds	
Peak/Classification Temperature (Tp)	260 °C	
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds	
Ramp-Down Rate	6 °C/second max.	
Time 25 °C to Peak Temperature	8 minutes max.	

Note 1: All temperatures refer to topside of the package, measured on the package body surface.



Picture 15: Soldering profile

7.7 Mounting and assembly recommendations

This HSMI-document provides all the necessary instructions to handle, solder and mount the environmental sensor BME680. Following the reported guidelines is very important to prevent the damage of the sensor and the resultant loss of warranty.

7.8 Environmental safety

7.8.1 RoHS

The BME680 sensor meets the requirements of the EC restriction of hazardous substances (RoHS) directive, see also: Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

7.8.2 Halogen content

The BME680 is halogen-free. For more details on the analysis results please contact your Bosch Sensortec representative.

7.8.3 Internal package structure

Within the scope of Bosch Sensortec's ambition to improve its products and secure the mass product supply, Bosch Sensortec qualifies additional sources (e.g. 2nd source) for the packaging and processing of the BME680.

While Bosch Sensortec took care that all of the technical packages parameters are described above are 100% identical for all sources, there can be differences in the chemical content and the internal structural between the different package sources.

However, as secured by the extensive product qualification process of Bosch Sensortec, this has no impact to the usage or to the quality of the BME680 product.

8. Legal disclaimer

8.1 Engineering samples

Engineering Samples are marked with an asterisk (*) or (e) or (E). Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

8.2 Product use

Bosch Sensortec products are developed for the consumer goods industry. They may only be used within the parameters of this product data sheet. They are not fit for use in life-sustaining or security sensitive systems. Security sensitive systems are those for which a malfunction is expected to lead to bodily harm or significant property damage. In addition, they are not fit for use in products which interact with motor vehicle systems.

The resale and/or use of products are at the purchaser's own risk and his own responsibility. The examination of fitness for the intended use is the sole responsibility of the Purchaser.

The purchaser shall indemnify Bosch Sensortec from all third party claims arising from any product use not covered by the parameters of this product data sheet or not approved by Bosch Sensortec and reimburse Bosch Sensortec for all costs in connection with such claims.

The purchaser must monitor the market for the purchased products, particularly with regard to product safety, and inform Bosch Sensortec without delay of all security relevant incidents.

8.3 Application examples and hints

With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Bosch Sensortec hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights or copyrights of any third party. The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. They are provided for illustrative purposes only and no evaluation regarding infringement of intellectual property rights or copyrights or regarding functionality, performance or error has been made.

9. Document history and modifications

Rev.	Chapter	Description of modifications	Date
1.0		Initial release	July 2017



Bosch Sensortec GmbH Gerhard-Kindler-Straße 9 72770 Reutlingen / Germany

www.bosch-sensortec.com

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